

## 16K-64K I<sup>2</sup>C Serial EEPROM with Software Write Protection Family Data Sheet

### Device Selection Table

| Part Number | Density | Page Size | Vcc Range | Package                  | Temp. Ranges |
|-------------|---------|-----------|-----------|--------------------------|--------------|
| 24CW16X     | 16-Kbit | 32-byte   | 1.6-5.5   | SN, OT, ST, MU           | I            |
| 24CW32X     | 32-Kbit | 32-byte   | 1.6-5.5   | SN, OT, ST, MU           | I            |
| 24CW64X     | 64-Kbit | 32-byte   | 1.6-5.5   | SN, OT, ST, MU, CS0, CS1 | I            |

**Note:** 'X' in the part number refers to the preset hardware slave address. Refer to [Table 3-2](#) for additional information.

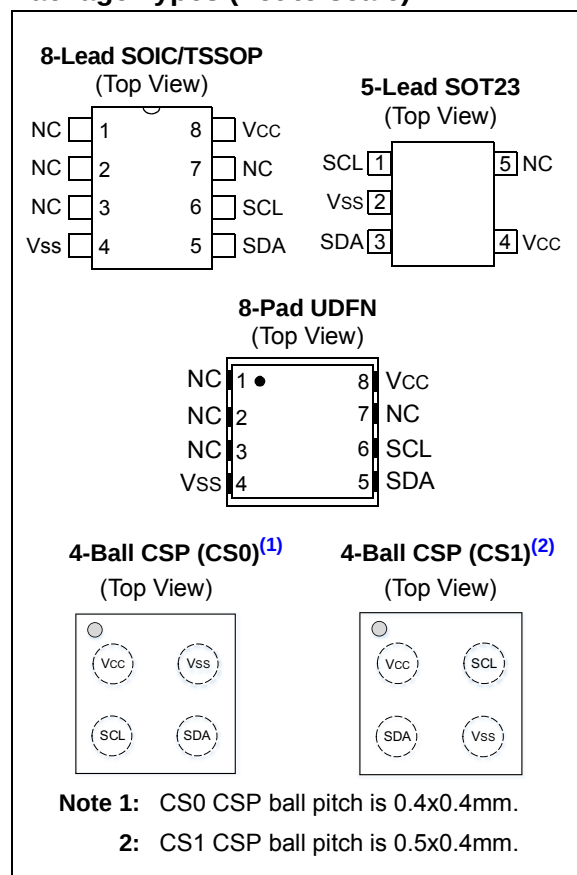
### Features

- 16/32/64-Kbit EEPROM:
  - Internally organized as one 2048/4096/8192 x 8 bit block
  - Byte or page writes up to 32 bytes
  - Byte or sequential reads within a block
  - Self-timed write cycle (5 ms maximum)
- High-Speed I<sup>2</sup>C Interface:
  - Industry standard: 1 MHz, 400 kHz and 100 kHz
  - Output slope control to eliminate ground bounce
  - Schmitt trigger inputs for noise suppression
- Programmable Hardware Slave Address Bits:
  - Configurable via the Hardware Address Register (HAR)
- Versatile Data Protection Options:
  - Software write protection via the Write Protection Register (WPR)
- Operating Voltage Range of 1.6V to 5.5V
- Low-Power CMOS Technology:
  - Write current: 1.0 mA maximum at 5.5V
  - Read current: 1.0 mA maximum at 5.5V, 1 MHz
  - Standby Current: 1  $\mu$ A at 5.5V
- High Reliability:
  - More than one million erase/write cycles
  - Data retention: >200 years
  - ESD protection: >4000V
- RoHS Compliant

### Packages

- 8-Lead SOIC, 8-Lead TSSOP, 8-Pad UDFN, 5-Lead SOT-23 and Two 4-Ball CSP options

### Package Types (not to scale)



### Pin Function Table

| Name | Function           |
|------|--------------------|
| Vss  | Ground             |
| SDA  | Serial Data Pin    |
| SCL  | Serial Clock Input |
| Vcc  | Supply Voltage     |

# 24CW16X/24CW32X/24CW64X

## Description

The 24CW16X/24CW32X/24CW64X (24CW Series) devices provide 16-64 Kbits of Serial EEPROM utilizing an I<sup>2</sup>C (2-wire) serial interface. The 24CW Series is organized as 2048/4096/8192 bytes of 8 bits each (2-8 Kbytes). The 24CW Series is optimized for use in consumer and industrial applications, where reliable and dependable nonvolatile memory storage is essential. The 24CW Series allows up to eight devices to share a common I<sup>2</sup>C (2-wire) bus and is capable of operation across a broad voltage range (1.6V to 5.5V).

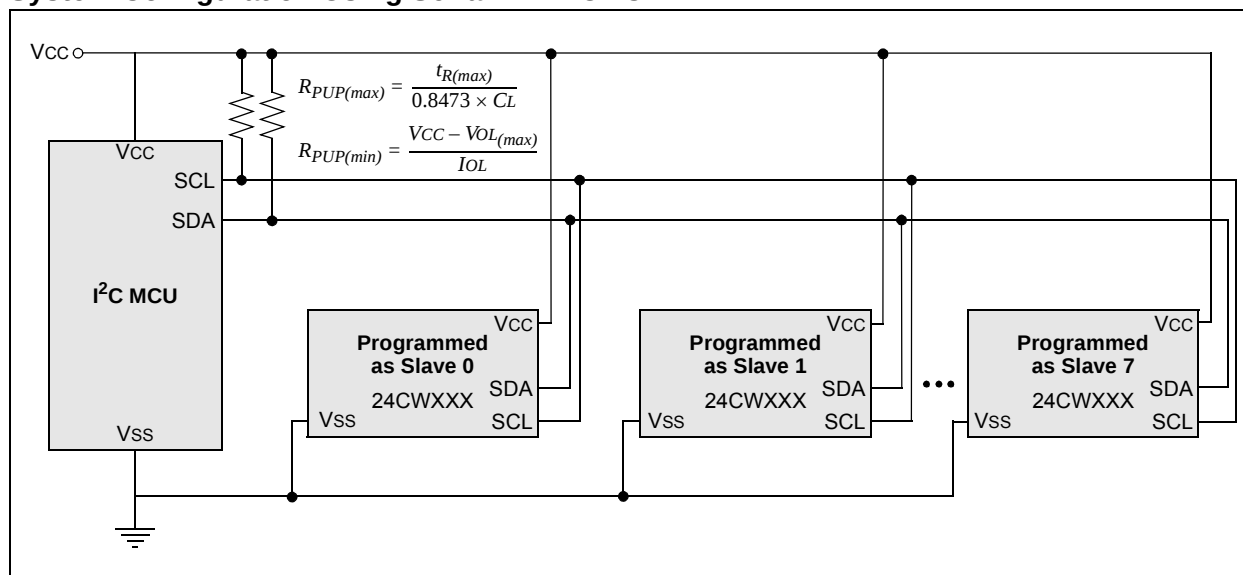
The 24CW Series contains a pair of programmable Configuration registers which allow certain device behaviors to be modified. These registers are the Write Protection Register and the Hardware Address Register.

The Write Protection Register (WPR) controls the valid address ranges of the EEPROM array that can be written. This allows the user to select the write protection behavior to be configured for software write protection.

The Hardware Address Register (HAR) controls the three hardware slave address bits. These bits determine which device addresses the 24CW Series will Acknowledge. Because the 24CW Series is a 4-pin device, the cascable feature is controlled by the HAR.

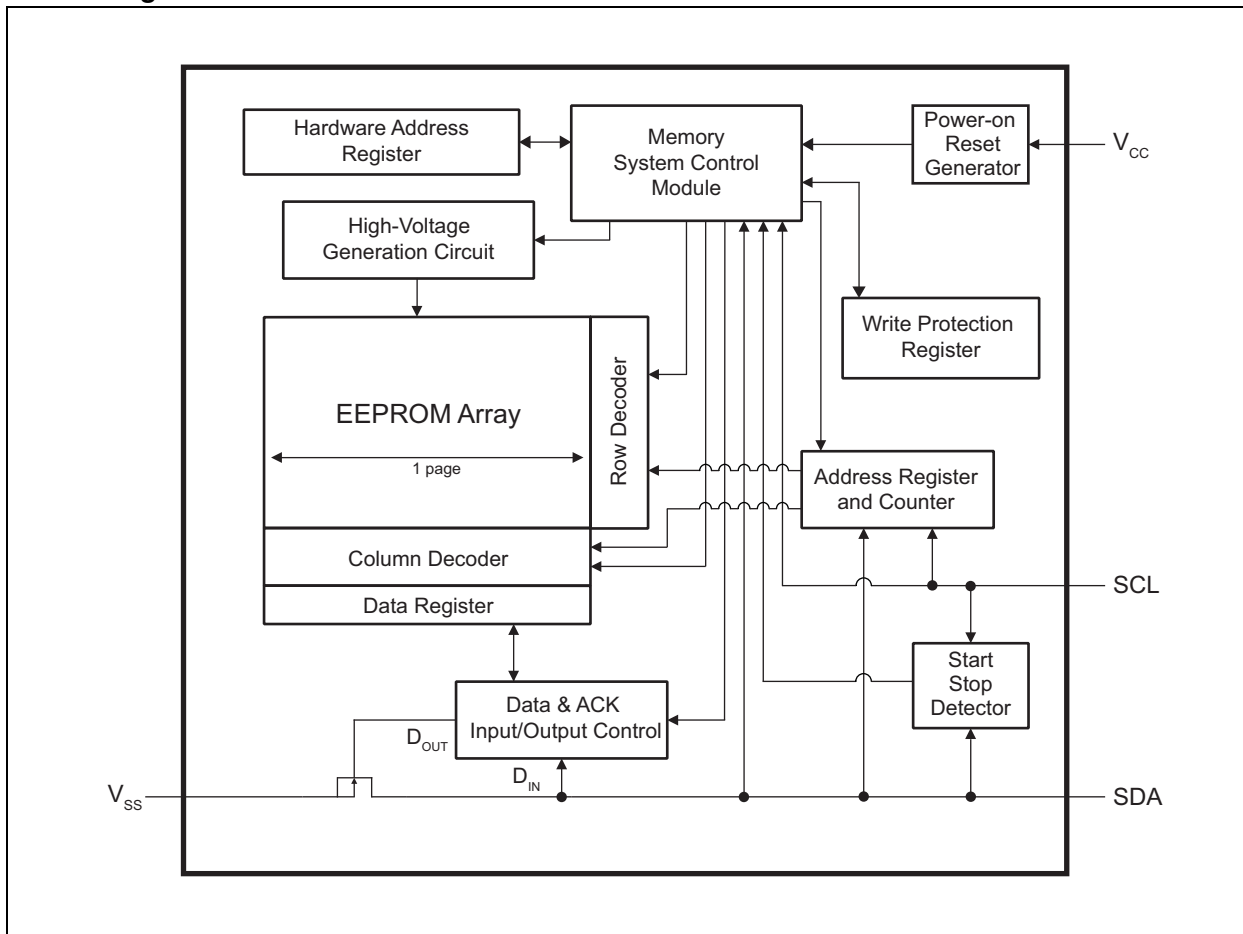
Once the desired software write protection and hardware slave address bits are set, these Configuration registers can be permanently locked, thereby preventing any further changes to the device operation.

## System Configuration Using Serial EEPROMs



# 24CW16X/24CW32X/24CW64X

## Block Diagram



# 24CW16X/24CW32X/24CW64X

## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings<sup>(†)</sup>

|                                                     |                 |
|-----------------------------------------------------|-----------------|
| V <sub>CC</sub> .....                               | 6.5V            |
| All inputs and outputs w.r.t. V <sub>SS</sub> ..... | -0.6V to 6.5V   |
| Storage temperature .....                           | -65°C to +150°C |
| Ambient temperature under bias .....                | -40°C to +85°C  |
| ESD protection on all pins .....                    | ≥4 kV           |

† **NOTICE:** Stresses above those listed under 'Maximum ratings' may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for an extended period of time may affect device reliability.

**TABLE 1-1: DC CHARACTERISTICS**

| DC CHARACTERISTICS |                      |                                                  | Electrical Characteristics:<br>Industrial (I): V <sub>CC</sub> = 1.6V to 5.5V T <sub>A</sub> = -40°C to +85°C |                       |       |                                                                                       |
|--------------------|----------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-----------------------|-------|---------------------------------------------------------------------------------------|
| Param. No.         | Symbol               | Characteristic                                   | Min.                                                                                                          | Max.                  | Units | Test Conditions                                                                       |
| D1                 | V <sub>IH</sub>      | High-Level Input Voltage                         | V <sub>CC</sub> × 0.7                                                                                         | V <sub>CC</sub> + 0.5 | V     |                                                                                       |
| D2                 | V <sub>IL</sub>      | Low-Level Input Voltage                          | -0.6                                                                                                          | V <sub>CC</sub> × 0.3 | V     |                                                                                       |
| D3                 | V <sub>OL</sub>      | Low-Level Output Voltage                         | —                                                                                                             | 0.4                   | V     | I <sub>OL</sub> = 2.1 mA, V <sub>CC</sub> = 3.0V                                      |
|                    |                      |                                                  | —                                                                                                             | 0.2                   | V     | I <sub>OL</sub> = 0.15 mA, V <sub>CC</sub> = 1.8V                                     |
| D4                 | I <sub>LI</sub>      | Input Leakage Current                            | —                                                                                                             | ±1                    | μA    | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                  |
|                    |                      |                                                  | —                                                                                                             | ±1                    | μA    | V <sub>IN</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                  |
| D5                 | I <sub>LO</sub>      | Output Leakage Current                           | —                                                                                                             | ±1                    | μA    | V <sub>OUT</sub> = V <sub>SS</sub> or V <sub>CC</sub>                                 |
| D6                 | C <sub>INT</sub>     | Internal Capacitance<br>(all inputs and outputs) | —                                                                                                             | 7                     | pF    | T <sub>AMB</sub> = +25°C, FREQ = 1.0 MHz,<br>V <sub>CC</sub> = 5.5V ( <b>Note 1</b> ) |
| D7                 | I <sub>CCREAD</sub>  | Operating Current                                | —                                                                                                             | 0.3                   | mA    | V <sub>CC</sub> = 1.8V, F <sub>CLK</sub> = 400 kHz                                    |
|                    |                      |                                                  | —                                                                                                             | 1                     | mA    | V <sub>CC</sub> = 5.5V, F <sub>CLK</sub> = 1 MHz                                      |
| D8                 | I <sub>CCWRITE</sub> | Operating Current                                | —                                                                                                             | 1                     | mA    | V <sub>CC</sub> = 5.5V, F <sub>CLK</sub> = 1 MHz                                      |
| D9                 | I <sub>CCS</sub>     | Standby Current                                  | —                                                                                                             | 0.5                   | μA    | SCL = SDA = V <sub>CC</sub> = 1.8V                                                    |
|                    |                      |                                                  | —                                                                                                             | 1.0                   | μA    | SCL = SDA = V <sub>CC</sub> = 5.5V                                                    |

**Note 1:** This parameter is not tested, but is ensured by characterization.

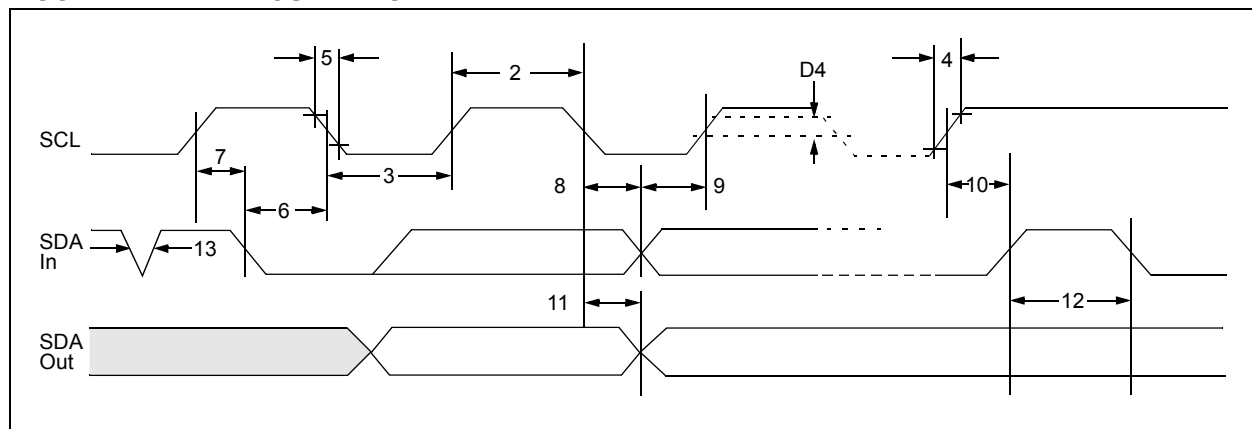
# 24CW16X/24CW32X/24CW64X

**TABLE 1-2: AC CHARACTERISTICS**

| AC CHARACTERISTICS |                     |                                                                          | Electrical Characteristics:<br>Industrial (I): V <sub>CC</sub> = 1.6V to 5.5V T <sub>A</sub> = -40°C to +85°C: |      |        |                                                       |
|--------------------|---------------------|--------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------|------|--------|-------------------------------------------------------|
| Param. No.         | Symbol              | Characteristic                                                           | Min.                                                                                                           | Max. | Units  | Conditions                                            |
| 1                  | FCLK                | Clock Frequency                                                          | —                                                                                                              | 1000 | kHz    | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 2                  | T <sub>HIGH</sub>   | Clock High Time                                                          | 260                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 3                  | T <sub>LOW</sub>    | Clock Low Time                                                           | 500                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 4                  | T <sub>R</sub>      | SDA and SCL Rise Time                                                    | —                                                                                                              | 1000 | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V (Note 1)                |
| 5                  | T <sub>F</sub>      | SDA and SCL Fall Time                                                    | —                                                                                                              | 300  | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V (Note 1)                |
| 6                  | T <sub>HD:STA</sub> | Start Condition Hold Time                                                | 260                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 7                  | T <sub>SU:STA</sub> | Start Condition Setup Time                                               | 260                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 8                  | T <sub>HD:DAT</sub> | Data Input Hold Time                                                     | 0                                                                                                              | —    | ns     | (Note 2)                                              |
| 9                  | T <sub>SU:DAT</sub> | Data Input Setup Time                                                    | 50                                                                                                             | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 10                 | T <sub>SU:STO</sub> | Stop Condition Setup Time                                                | 260                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 11                 | T <sub>AA</sub>     | Output Valid from Clock                                                  | —                                                                                                              | 450  | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 12                 | T <sub>BUF</sub>    | Bus Free Time: Bus Time must be Free before a New Transmission can Start | 500                                                                                                            | —    | ns     | 1.6V ≤ V <sub>CC</sub> ≤ 5.5V                         |
| 13                 | T <sub>SP</sub>     | Input Filter Spike Suppression (SDA and SCL pins)                        | —                                                                                                              | 50   | ns     | (Note 3)                                              |
| 14                 | T <sub>WC</sub>     | Write Cycle Time (byte or page)                                          | —                                                                                                              | 5    | ms     |                                                       |
| 15                 |                     | Endurance                                                                | 1,000,000                                                                                                      | —    | cycles | V <sub>CC</sub> = 5.5V, +25°C, per data byte (Note 4) |

- Note 1:** The rise/fall times must be less than the specified maximums in order to achieve the maximum clock frequencies specified for FCLK. Please refer to the I<sup>2</sup>C specification for applicable timings.
- 2:** As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.
- 3:** Not 100% tested. C<sub>B</sub> = total capacitance of one bus line in pF.
- 4:** This parameter is not tested but ensured by characterization.

**FIGURE 1-1: BUS TIMING DATA**



# 24CW16X/24CW32X/24CW64X

## 1.1 Power-up Requirements and Reset Behavior

During a power-up sequence, the VCC supplied to the 24CW Series should monotonically rise from VSS to the minimum VCC level, as specified in [Table 1-1](#), with a slew rate no faster than 0.1V/μs.

### 1.1.1 DEVICE RESET

To prevent write operations or other spurious events from happening during a power-up sequence, the 24CW Series includes a Power-on Reset (POR) circuit. Upon power-up, the device will not respond to any commands until the VCC level crosses the internal voltage threshold (VPOR) that brings the device out of Reset and into Standby mode.

The system designer must ensure that instructions are not sent to the device until the VCC supply has reached a stable value greater than, or equal to, the minimum VCC level. Additionally, once the VCC is greater than, or equal to, the minimum VCC level, the master must wait at least tPUP before sending the first command to the device. See [Table 1-3](#) for the values associated with these power-up parameters.

If an event occurs in the system where the VCC level supplied to the 24CW Series drops below the maximum VPOR level specified, it is recommended that a full-power cycle sequence be performed by first driving the VCC pin to VSS, waiting at least the minimum tPOFF time, and then perform a new power-up sequence in compliance with the requirements defined in [Section 1.1 “Power-up Requirements and Reset Behavior”](#).

**TABLE 1-3: POWER-UP CONDITIONS**

| Symbol | Parameter                                                               | Min. | Max. | Units |
|--------|-------------------------------------------------------------------------|------|------|-------|
| tPUP   | Time Required after VCC is Stable before the Device can Accept Commands | 100  | —    | μs    |
| VPOR   | Power-on Reset Threshold Voltage                                        | —    | 1.5  | V     |
| tPOFF  | Minimum Time at VCC = 0V between Power Cycles                           | 1    | —    | ms    |

## 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in [Table 2-1](#).

**TABLE 2-1: PIN FUNCTION TABLE**

| Name | 8-Lead SOIC | 8-Lead TSSOP | 5-Lead SOT23 | 8-Lead UDFN <sup>(1)</sup> | 4-Ball CSP (CS0) <sup>(2)</sup> | 4-Ball CSP (CS1) <sup>(3)</sup> | Function            |
|------|-------------|--------------|--------------|----------------------------|---------------------------------|---------------------------------|---------------------|
| NC   | 1           | 1            | —            | 1                          | —                               | —                               | No Connect          |
| NC   | 2           | 2            | —            | 2                          | —                               | —                               | No Connect          |
| NC   | 3           | 3            | —            | 3                          | —                               | —                               | No Connect          |
| VSS  | 4           | 4            | 2            | 4                          | A2                              | B2                              | Ground              |
| SDA  | 5           | 5            | 3            | 5                          | B2                              | B1                              | Serial Data         |
| SCL  | 6           | 6            | 1            | 6                          | B1                              | A2                              | Serial Clock        |
| NC   | 7           | 7            | 5            | 7                          | —                               | —                               | No Connect          |
| VCC  | 8           | 8            | 4            | 8                          | A1                              | A1                              | Device Power Supply |

**Note 1:** The exposed pad on the UDFN package can be connected to VSS or left floating.

**2:** CS0 CSP ball pitch is 0.4x0.4mm.

**3:** CS1 CSP ball pitch is 0.5x0.4mm.

### 2.1 Serial Data (SDA)

This is a bidirectional pin used to transfer addresses and data into and out of the device. It is an open-drain terminal, therefore, the SDA bus requires a pull-up resistor to VCC (typical 10 kΩ for 100 kHz and 2 kΩ for 400 kHz and 1 MHz).

For normal data transfer, SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the Start and Stop conditions.

### 2.2 Serial Clock (SCL)

This input is used to synchronize the data transfer from and to the device.

# 24CW16X/24CW32X/24CW64X

## 3.0 MEMORY ORGANIZATION

### 3.1 EEPROM Organization

The 24CW Series is internally organized as 64/128/256 pages of 32 bytes each, depending on the density.

### 3.2 Device Configuration Registers

The 24CW Series contains two Configuration registers that modulate device operation and/or report on the current status of the device. These registers are:

- Write Protection Register (WPR)
- Hardware Address Register (HAR)

Once the device behavior is set as desired, the Configuration registers can be permanently locked (or set to read-only), thereby preventing any subsequent changes.

#### 3.2.1 WRITE PROTECTION REGISTER

The Write Protection Register (WPR) allows for modification of the device write protection behavior. Refer to [Section 8.2 “Write Protection Register”](#) for additional information of the WPR.

#### 3.2.2 HARDWARE ADDRESS REGISTER

The Hardware Address Register (HAR) allows for modification of the hardware slave address bits in the device address byte that the device will Acknowledge. Refer to [Section 8.3 “Hardware Address Register”](#) for additional information on the HAR.

## 3.3 Device Addressing

Communication with the 24CW Series begins with an 8-bit device address byte, comprised of a 7-bit slave address and a Read/Write Select (R/W) bit. Since multiple slave devices can reside on the serial bus, each slave device must have its own unique device address, programmed in the HAR, so that the master can access each device independently.

The 7-bit slave address is constructed using two groups of bits. The first four bits contain the Device Type Identifier, followed by three bits containing the hardware slave address bits.

The 24CW Series will respond to only specific Device Type Identifiers, as shown in [Section 3.3.1 “Valid Device Address Byte Inputs”](#).

The 3-bit hardware slave address is comprised of bits A2, A1 and A0. These bits can be used to expand the address space by allowing up to eight devices with the same Device Type Identifiers on the bus. These hardware slave address bits must correlate with the values programmed in the HAR.

The device will respond to all valid device address byte combinations that it receives.

#### 3.3.1 VALID DEVICE ADDRESS BYTE INPUTS

The 24CW Series will respond to the Device Type Identifiers, as shown in [Table 3-1](#).

##### 3.3.1.1 Preset Slave Addresses

The 24CW Series is preset with a specific slave address. The preset slave address bits are embedded in the base part number, as shown in [Table 3-2](#).

TABLE 3-1: TABLE OF VALID DEVICE ADDRESS BYTES

| Access Region           | Device Type Identifier |       |       |       | Hardware Slave Address |       |       | Read/Write Select |
|-------------------------|------------------------|-------|-------|-------|------------------------|-------|-------|-------------------|
|                         | Bit 7                  | Bit 6 | Bit 5 | Bit 4 | Bit 3                  | Bit 2 | Bit 1 | Bit 0             |
| EEPROM                  | 1                      | 0     | 1     | 0     | A2                     | A1    | A0    | R/W               |
| Configuration Registers | 1                      | 0     | 1     | 0     | A2                     | A1    | A0    | R/W               |

**Note:** The access region is selected according to bit 7 of the first word address byte. Refer to [Section 3.3.2 “Word Address Bytes”](#) for additional information.

# 24CW16X/24CW32X/24CW64X

**TABLE 3-2: DEVICE PRESET SLAVE ADDRESS**

| Part Number Series<br>24CWXXX | Hardware Slave Address Bits |    |    |
|-------------------------------|-----------------------------|----|----|
|                               | A2                          | A1 | A0 |
| 24CWXX0 <sup>(1)</sup>        | 0                           | 0  | 0  |
| 24CWXX1 <sup>(1,2)</sup>      | 0                           | 0  | 1  |
| 24CWXX2 <sup>(1,2)</sup>      | 0                           | 1  | 0  |
| 24CWXX3 <sup>(1,2)</sup>      | 0                           | 1  | 1  |
| 24CWXX4 <sup>(1,2)</sup>      | 1                           | 0  | 0  |
| 24CWXX5 <sup>(1,2)</sup>      | 1                           | 0  | 1  |
| 24CWXX6 <sup>(1,2)</sup>      | 1                           | 1  | 0  |
| 24CWXX7 <sup>(1,2)</sup>      | 1                           | 1  | 1  |

- Note 1:** 'XX' in the part number varies depending on the density.
- 2:** Contact your local sales representative for hardware slave address availability.

## 3.3.1.2 Read/Write Select Bit

The eighth bit (bit 0) of the device address byte is the Read/Write Select (R/W) bit. A read operation is initiated if this bit is a logic '1' and a write operation is initiated if this bit is a logic '0'.

Upon the successful comparison of the device address byte, the 24CW Series will respond. If a valid comparison is not made, the device will not respond and return to a standby state.

## 3.3.2 WORD ADDRESS BYTES

Two 8-bit word address bytes are transmitted to the device immediately following the device address byte.

The first word address byte contains the Most Significant bits (MSBs) of the memory array word address to specify which location in the EEPROM to start reading or writing. Note that the number of word address bits depends on the density.

When accessing the memory array, it is required that bit 7 of the word address byte be set to a logic '0'. When accessing the Configuration registers, it is required that bit 7 of the first word address byte be set to a logic '1'. Refer to [Table 3-3](#) for details.

Next, the second word address byte is sent to the device which provides the remaining eight bits of the word address (A7 through A0). Refer to [Table 3-4](#) for details.

**TABLE 3-3: FIRST WORD ADDRESS BYTE**

| Memory Region           | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| 16-Kbit EEPROM          | 0     | x     | x     | x     | x     | A10   | A9    | A8    |
| 32-Kbit EEPROM          | 0     | x     | x     | x     | A11   | A10   | A9    | A8    |
| 64-Kbit EEPROM          | 0     | x     | x     | A12   | A11   | A10   | A9    | A8    |
| Configuration Registers | 1     | x     | x     | x     | x     | x     | x     | x     |

**TABLE 3-4: SECOND WORD ADDRESS BYTE**

| Memory Region                          | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|----------------------------------------|-------|-------|-------|-------|-------|-------|-------|-------|
| 16-Kbit EEPROM                         | A7    | A6    | A5    | A4    | A3    | A2    | A1    | A0    |
| 32-Kbit EEPROM                         | A7    | A6    | A5    | A4    | A3    | A2    | A1    | A0    |
| 64-Kbit EEPROM                         | A7    | A6    | A5    | A4    | A3    | A2    | A1    | A0    |
| Configuration Registers <sup>(1)</sup> | x     | x     | x     | x     | x     | x     | x     | x     |

- Note 1:** When accessing the Configuration registers, the second word address byte must be transmitted to the device despite containing only don't care values.

# 24CW16X/24CW32X/24CW64X

## 4.0 FUNCTIONAL DESCRIPTION

The 24CW Series supports a bidirectional 2-wire bus and data transmission protocol. A device that sends data onto the bus is defined as a transmitter and a device receiving data as a receiver. The bus must be controlled by a master which generates the Serial Clock (SCL), controls the bus access and generates the Start and Stop conditions, while the 24CW Series works as a slave. Both master and slave can operate as a transmitter or receiver, but the master determines which mode is activated.

## 5.0 BUS CHARACTERISTICS

The following bus protocol has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high. Changes in the data line, while the clock line is high, will be interpreted as a Start or Stop condition.

Accordingly, the following bus conditions have been defined (Figure 5-1).

### 5.1 Bus Not Busy (A)

Both data and clock lines remain high.

### 5.2 Start Data Transfer (B)

A high-to-low transition of the SDA line while the clock (SCL) is high determines a Start condition. All commands must be preceded by a Start condition.

### 5.3 Stop Data Transfer (C)

A low-to-high transition of the SDA line while the clock (SCL) is high determines a Stop condition. All operations must end with a Stop condition.

### 5.4 Data Valid (D)

The state of the data line represents valid data when, after a Start condition, the data line is stable for the duration of the high period of the clock signal.

The data on the line must be changed during the low period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a Start condition and terminated with a Stop condition. The number of the data bytes transferred between the Start and Stop conditions is determined by the master.

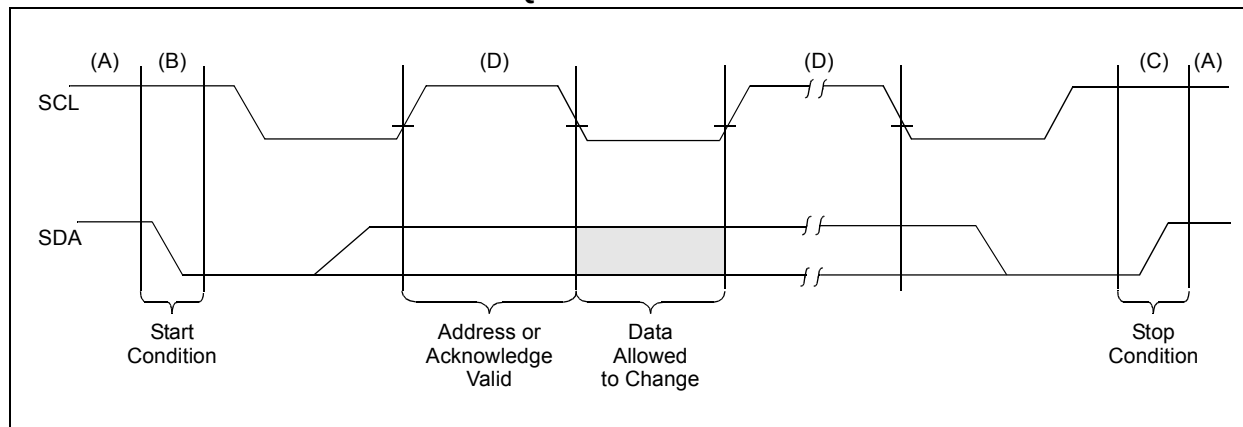
### 5.5 Acknowledge

Each receiving device, when addressed, is obliged to generate an Acknowledge signal after the reception of each byte. The master must generate an extra clock pulse, which is associated with this Acknowledge bit. See Figure 5-2 for Acknowledge timing.

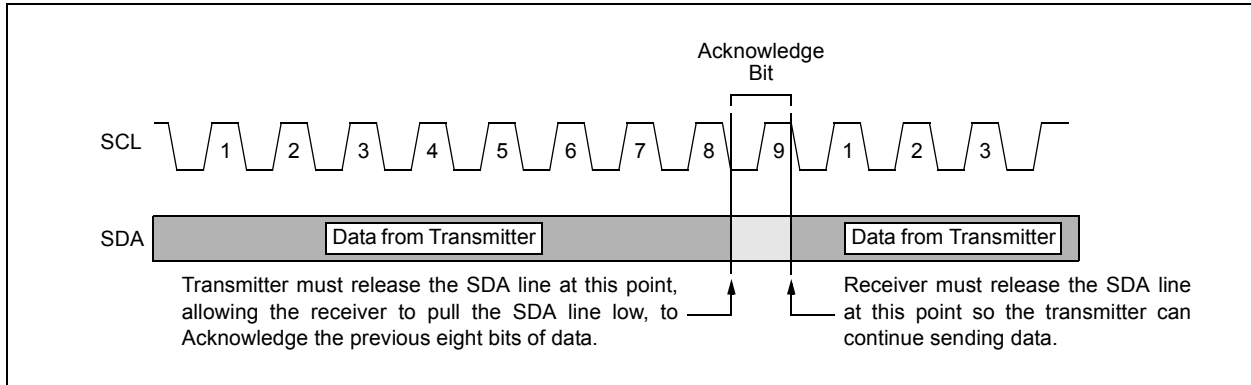
**Note:** The 24CW Series does not generate any Acknowledge bits if an internal programming cycle is in progress.

A device that Acknowledges must pull down the SDA line during the Acknowledge clock pulse, in such a way, that the SDA line is stable low during the high period of the Acknowledge related clock pulse. Of course, setup and hold times must be taken into account. During read operations, the master must signal an end of data to the slave by NOT generating an Acknowledge (NACK) bit on the last byte that has been clocked out of the slave. In this case, the slave (24CW Series) will leave the data line high to enable the master to generate the Stop condition.

FIGURE 5-1: DATA TRANSFER SEQUENCE ON THE SERIAL BUS



**FIGURE 5-2: ACKNOWLEDGE TIMING**



## 5.6 Standby Mode

The 24CW Series features a low-power Standby mode which is enabled when any one of the following occurs:

- A valid power-up sequence is performed (see [Section 1.1 “Power-up Requirements and Reset Behavior”](#)).
- A Stop condition is received by the device unless it initiates an internal write cycle (see [Section 6.0 “Write Operations”](#)).
- At the completion of an internal write cycle (see [Section 6.0 “Write Operations”](#)).
- An unsuccessful match of the Device Type Identifier or hardware slave address in the device address byte occurs (see [Section 3.3 “Device Addressing”](#)).
- The master does not Acknowledge the receipt of data read out from the device; instead, it sends a NACK response. (see [Section 7.0 “Read Operations”](#)).

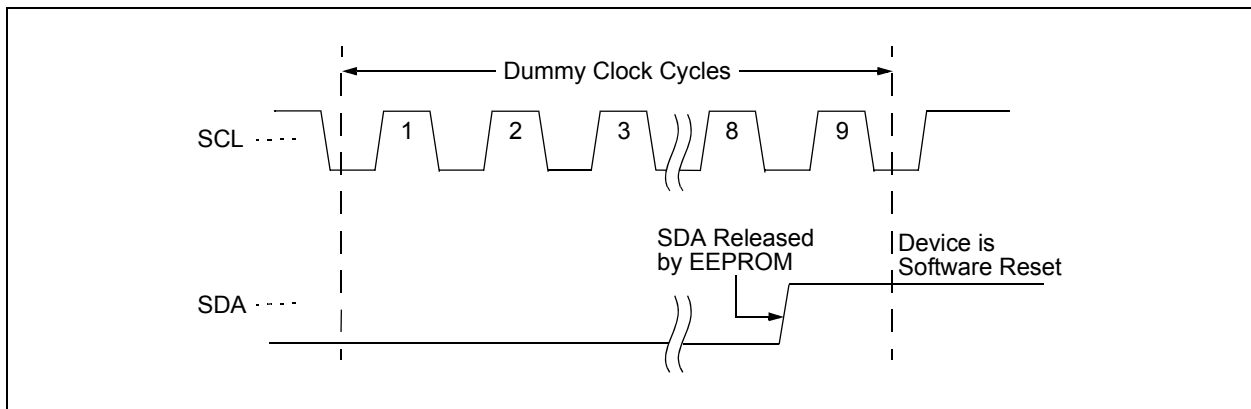
## 5.7 Software Reset

After an interruption in protocol, power loss or system Reset, any 2-wire device can be protocol reset by clocking SCL until SDA is released by the EEPROM and goes high. The number of clock cycles until SDA is released by the EEPROM will vary. The Software Reset sequence should not take more than nine dummy clock cycles. Note that the Software Reset sequence will not interrupt the internal write cycle and only resets the I<sup>2</sup>C interface.

Once the Software Reset sequence is complete, new protocol can be sent to the device by sending a Start condition, followed by the protocol. [Figure 5-3](#) illustrates the Software Reset sequence.

In the event that the device is still non-responsive, or remains active on the SDA bus, a power cycle must be used to reset the device (see [Section 1.1.1 “Device Reset”](#)).

**FIGURE 5-3: SOFTWARE RESET**



# 24CW16X/24CW32X/24CW64X

## 6.0 WRITE OPERATIONS

All write operations for the 24CW Series begin with the master sending a Start condition, followed by a device address byte with the  $R/\overline{W}$  bit set to a logic '0', and then by the word address bytes. The data value(s) to be written to the device immediately follows the word address bytes.

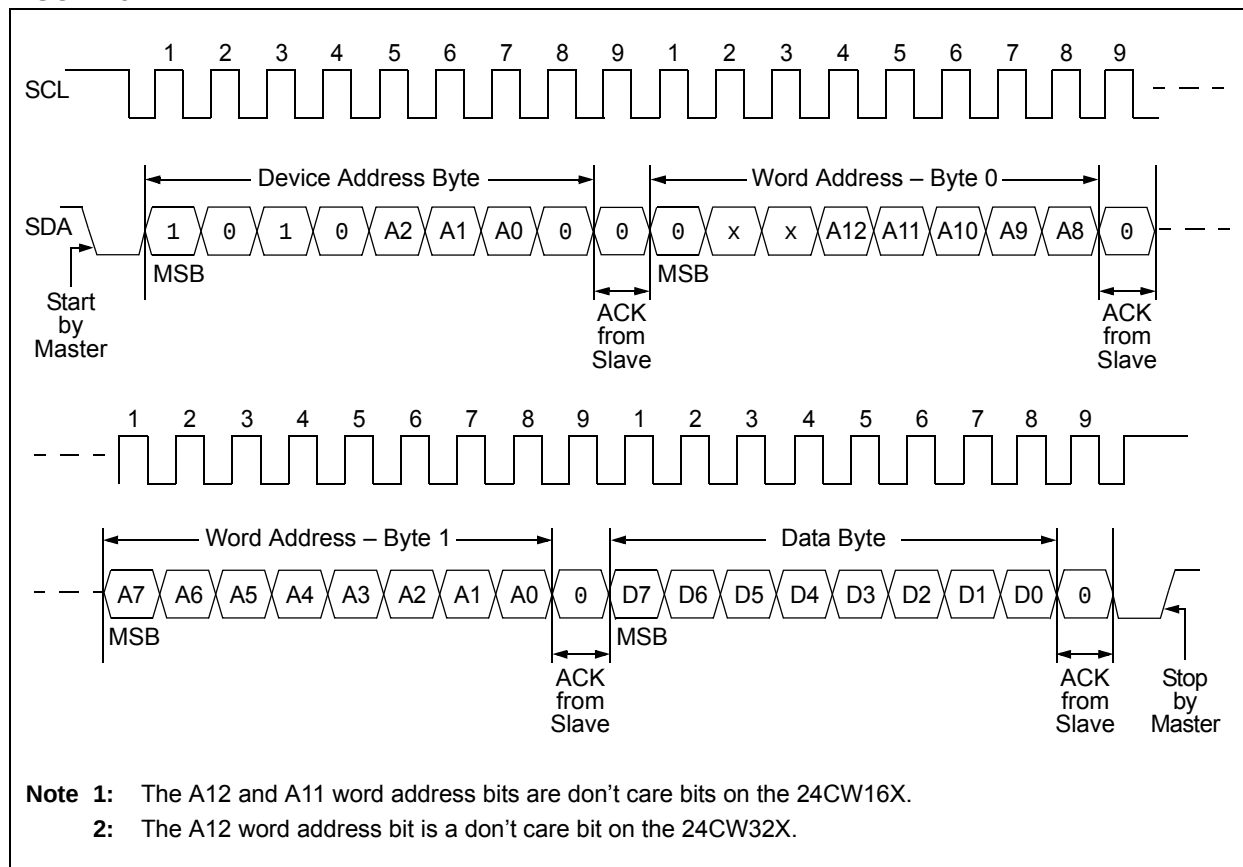
### 6.1 Byte Write

The 24CW Series supports the writing of a single 8-bit byte. Selecting a data byte in the 24CW Series requires a two-byte word address with the MSb set to a logic '0'. Note that some word address bits are ignored and the number of ignored bits depends on the device density.

Upon receipt of the proper device address and word address bytes, the EEPROM will send an Acknowledge. The device will then be ready to receive the first 8-bit data byte. Following the receipt of the data byte, the EEPROM will respond with an Acknowledge. The addressing device, such as a master, must then terminate the write operation with a Stop condition. At that time, the EEPROM will enter an internally self-timed write cycle, which will be completed within  $t_{WC}$ , while the data byte is being programmed into the nonvolatile EEPROM. All inputs are disabled during this write cycle and the EEPROM will not respond until the write operation is complete.

If an attempt is made to write to a write-protected portion of the array, no data will be written and the device will immediately accept a new command.

**FIGURE 6-1: BYTE WRITE**



## 6.2 Page Write

A page write operation allows up to 32 bytes to be written in the same write cycle, provided all bytes are in the same page of the memory array. Partial page writes of less than 32 bytes are also allowed.

A page write is initiated the same way as a byte write, but the master does not send a Stop condition after the first data byte is clocked in. Instead, after the EEPROM Acknowledges receipt of the first data byte, the master can transmit up to 31 additional data bytes. The EEPROM will respond with an ACK after each data byte is received.

Once all data to be written has been sent to the device, the master must issue a Stop condition (see Figure 6-2). Once the Stop condition is received, an internal write cycle will begin.

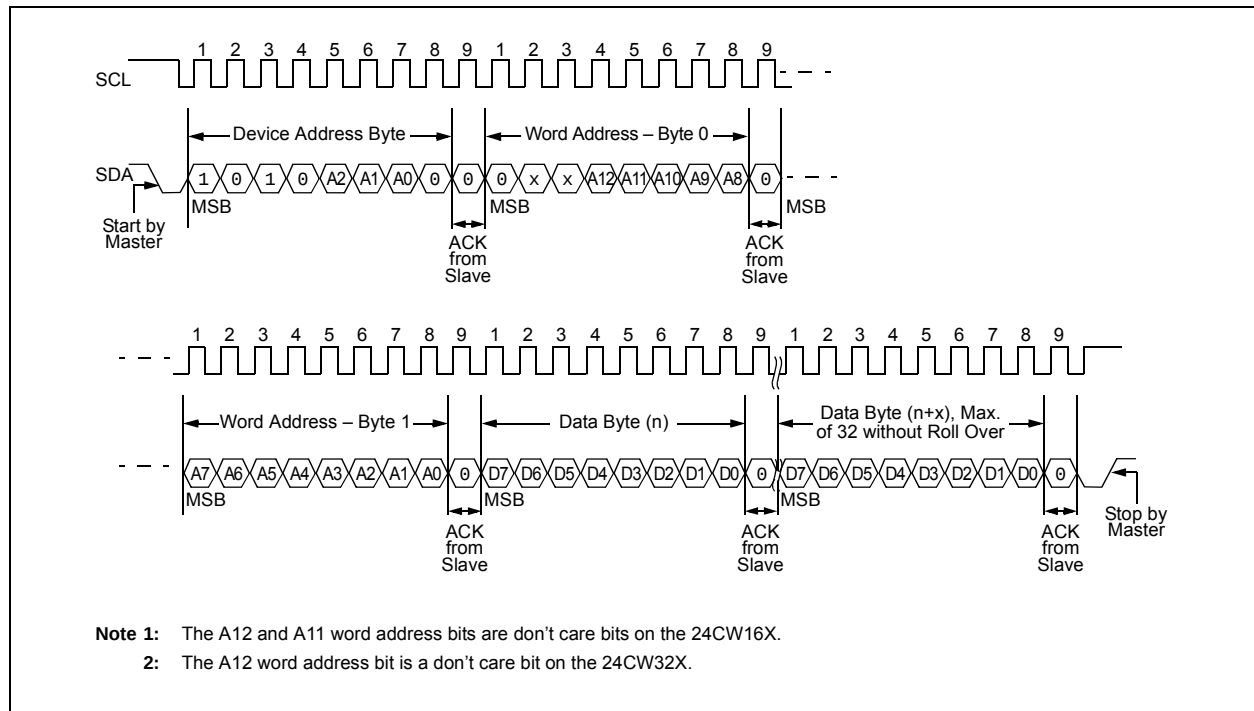
If an attempt is made to write to a write-protected portion of the array, no data will be written and the device will immediately accept a new command.

The lower five bits of the word address are internally incremented following the receipt of each data byte. The higher order address bits are not incremented and retain the memory page location.

When the incremented word address reaches the page boundary, the address counter will roll over to the beginning of the same page.

**Note:** Page write operations are limited to writing bytes within a single physical page, **regardless** of the number of bytes actually being written. Physical page boundaries start at addresses that are integer multiples of the page buffer size (or 'page size') and end at the addresses that are integer multiples of [page size – 1]. If a page write operation attempts to write across a physical page boundary, the result is that the data wraps around to the beginning of the current page (overwriting data previously stored there), instead of being written to the next page as might be expected. It is therefore necessary for the application software to prevent page write operations that would attempt to cross a page boundary.

**FIGURE 6-2: PAGE WRITE**



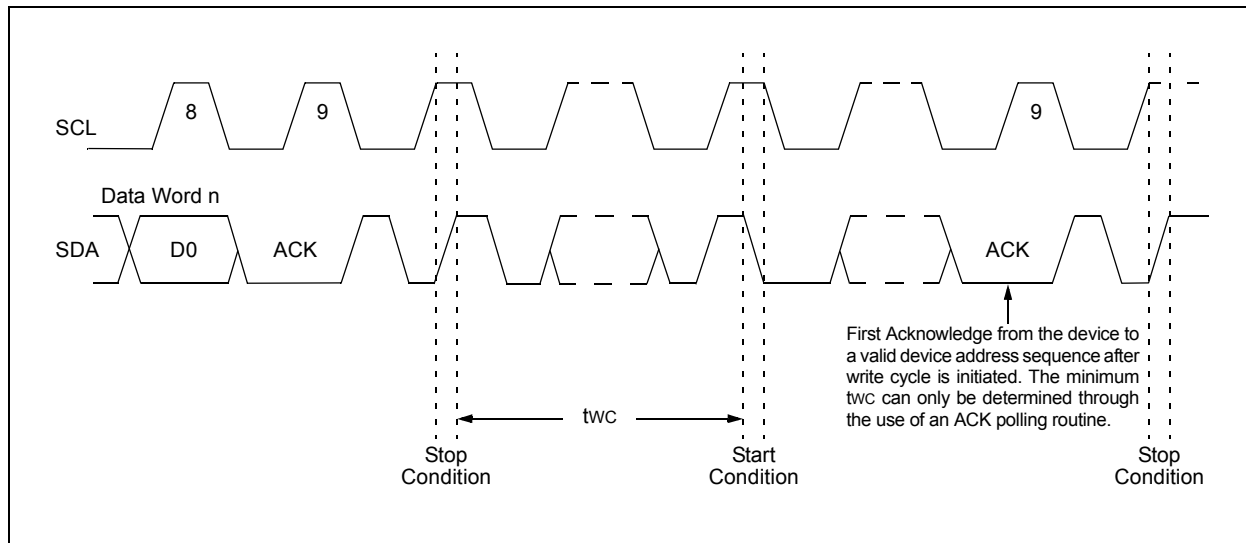
# 24CW16X/24CW32X/24CW64X

## 6.3 Write Cycle Timing

The length of the self-timed write cycle, or twc, is defined as the amount of time from the Stop condition that begins the internal write operation, to the Start condition of the first device address byte sent to the 24CW Series that it subsequently responds to with an ACK (see [Figure 6-3](#)).

During the internally self-timed write cycle, any attempts to read from, or write to, the memory array will not be processed.

**FIGURE 6-3: WRITE CYCLE TIMING**

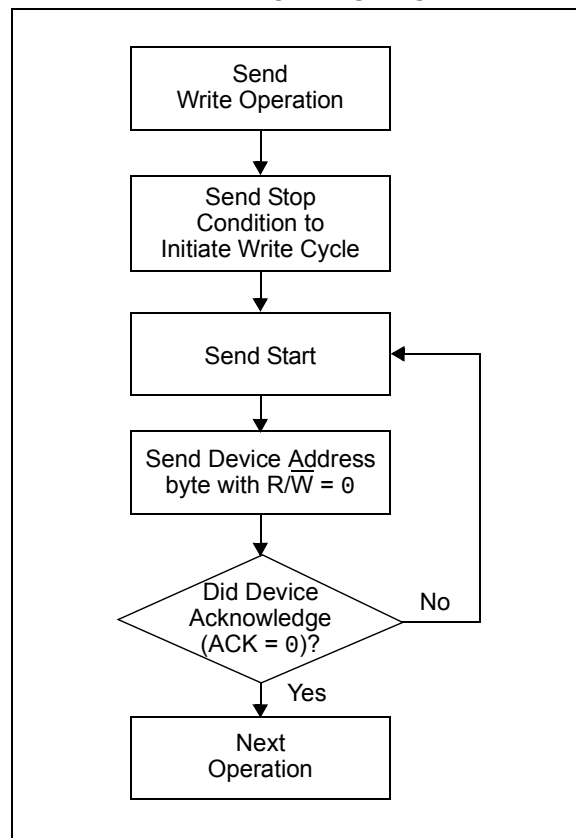


## 6.4 Acknowledge Polling

Since the device will not Acknowledge during a write cycle, this can be used to determine when the cycle is complete (this feature can be used to maximize bus throughput). Once the Stop condition for a write operation has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a Start condition, followed by the device address byte for a write operation ( $R/\overline{W} = 0$ ). If the device is still busy with the write cycle, then a NACK will be returned. If a NACK is returned, then the Start bit and device address byte must be resent. If the cycle is complete, then the device will return the ACK and the master can then proceed with the next read or write operation. See Figure 6-4 for the flow diagram.

**Note:** If the user is polling after writing to the Hardware Address Register (HAR), the user must send the new hardware slave address to determine whether the write cycle is complete. If the 24CW Series doesn't ACK the new hardware slave address after the maximum write cycle time (twc), the write to the HAR was not successful.

FIGURE 6-4: ACKNOWLEDGE POLLING FLOW



# 24CW16X/24CW32X/24CW64X

## 6.5 Write Protection

The 24CW Series write protection is controlled via the Write Protection Register (WPR). The 24CW Series is segmented into four different memory zones, which allows the user to select which of the zones will be soft-

ware write-protected. The protection behavior can be made permanent by locking the Configuration registers. For additional information on the Write Protection Register, see [Section 8.2 “Write Protection Register”](#).

**TABLE 6-1: 24CW SERIES SOFTWARE WRITE PROTECTION**

| Protection Level | Protected Address Range |             |             |
|------------------|-------------------------|-------------|-------------|
|                  | 24CW16X                 | 24CW32X     | 24CW64X     |
| None             | None                    | None        | None        |
| Upper 1/4        | 0600h-07FFh             | 0C00h-0FFFh | 1800h-1FFFh |
| Upper 1/2        | 0400h-07FFh             | 0800h-0FFFh | 1000h-1FFFh |
| Upper 3/4        | 0200h-07FFh             | 0400h-0FFFh | 0800h-1FFFh |
| Entire Array     | 0000h-07FFh             | 0000h-0FFFh | 0000h-1FFFh |

## 7.0 READ OPERATIONS

Read operations are initiated the same way as write operations, with the exception that the Read/Write Select (R/W) bit in the device address byte must be a logic '1'. There are three read operations:

- Current Address Read
- Random Address Read
- Sequential Read

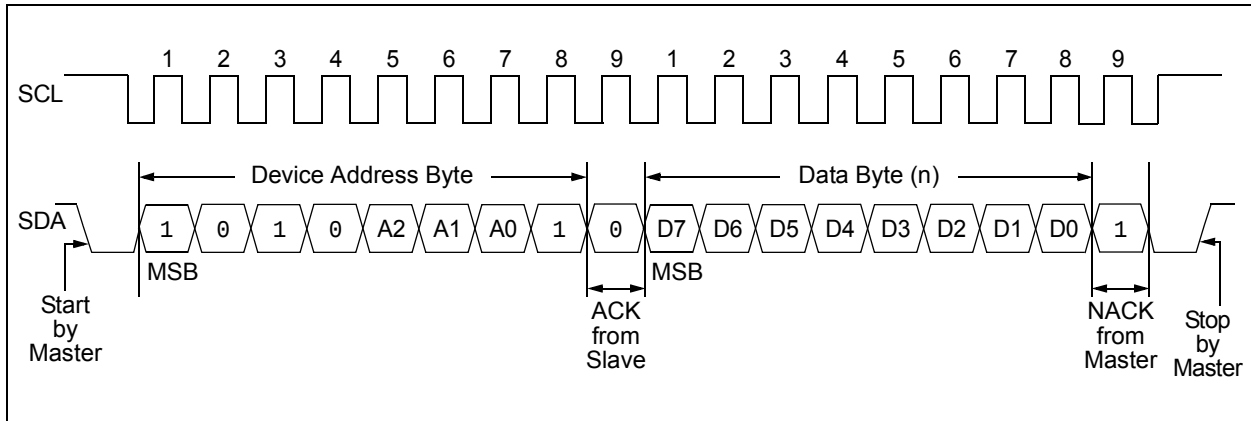
### 7.1 Current Address Read

The 24CW Series contains an internal Address Pointer that maintains the word address of the last byte accessed, internally incremented by one. Therefore, if

the previous read access was to address 'n' (n is any legal address), the next current address read operation would access data from address n+1.

A current address read operation will output data according to the location of the internal Address Pointer. This is initiated with a Start condition, followed by a valid device address byte with the R/W bit set to logic '1'. The device will ACK this sequence and the current address data byte is serially clocked out on the SDA line. All types of read operations will be terminated if the master does not respond with an ACK (it NACKs) during the ninth clock cycle, which will force the device into Standby mode. After the NACK response, the master may send a Stop condition to complete the protocol or it can send a Start condition to begin the next sequence.

**FIGURE 7-1: CURRENT ADDRESS READ**



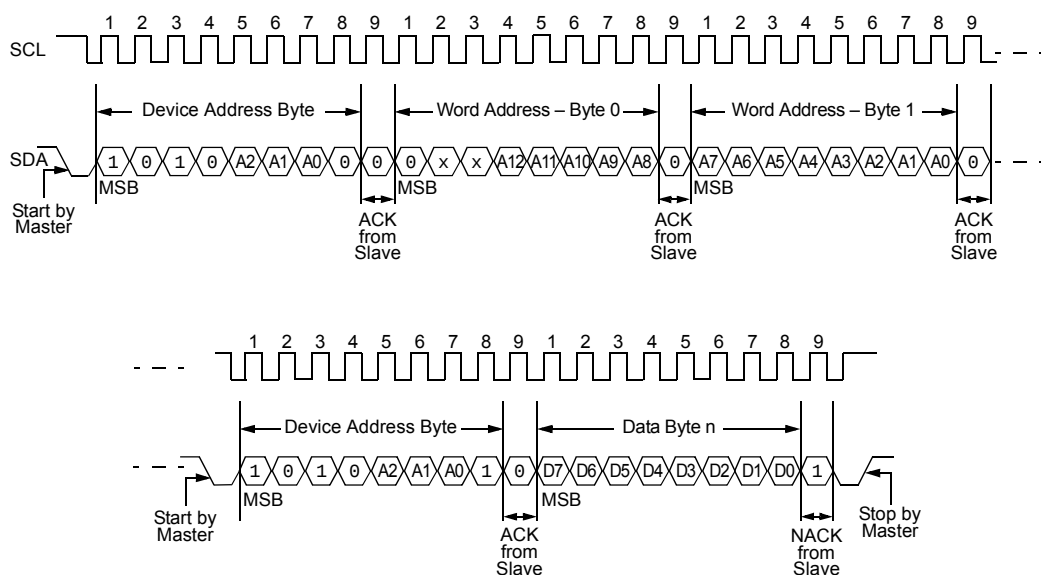
# 24CW16X/24CW32X/24CW64X

## 7.2 Random Read

Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, first the word address must be set. This is done by sending the word address, with the MSb set to logic '0', to the 24CW Series as part of a write operation (R/W bit set to '0'). After the word address is sent, the master generates a Start condition following the Acknowledge. This terminates the write operation, but not before the internal Address Pointer is

set. Then, the master issues the device address byte again, but with the R/W bit set to a '1'. The 24CW Series will then issue an Acknowledge and transmit the 8-bit data byte. The master will not Acknowledge the transfer, but does generate a Stop condition which causes the 24CW Series to discontinue transmission (Figure 7-2). After a random read operation, the internal Address Pointer will point to the last word address location, incremented by one.

**FIGURE 7-2: RANDOM READ**



- Note 1:** The A12 and A11 word address bits are don't care bits on the 24CW16X.  
**Note 2:** The A12 word address bit is a don't care bit on the 24CW32X.

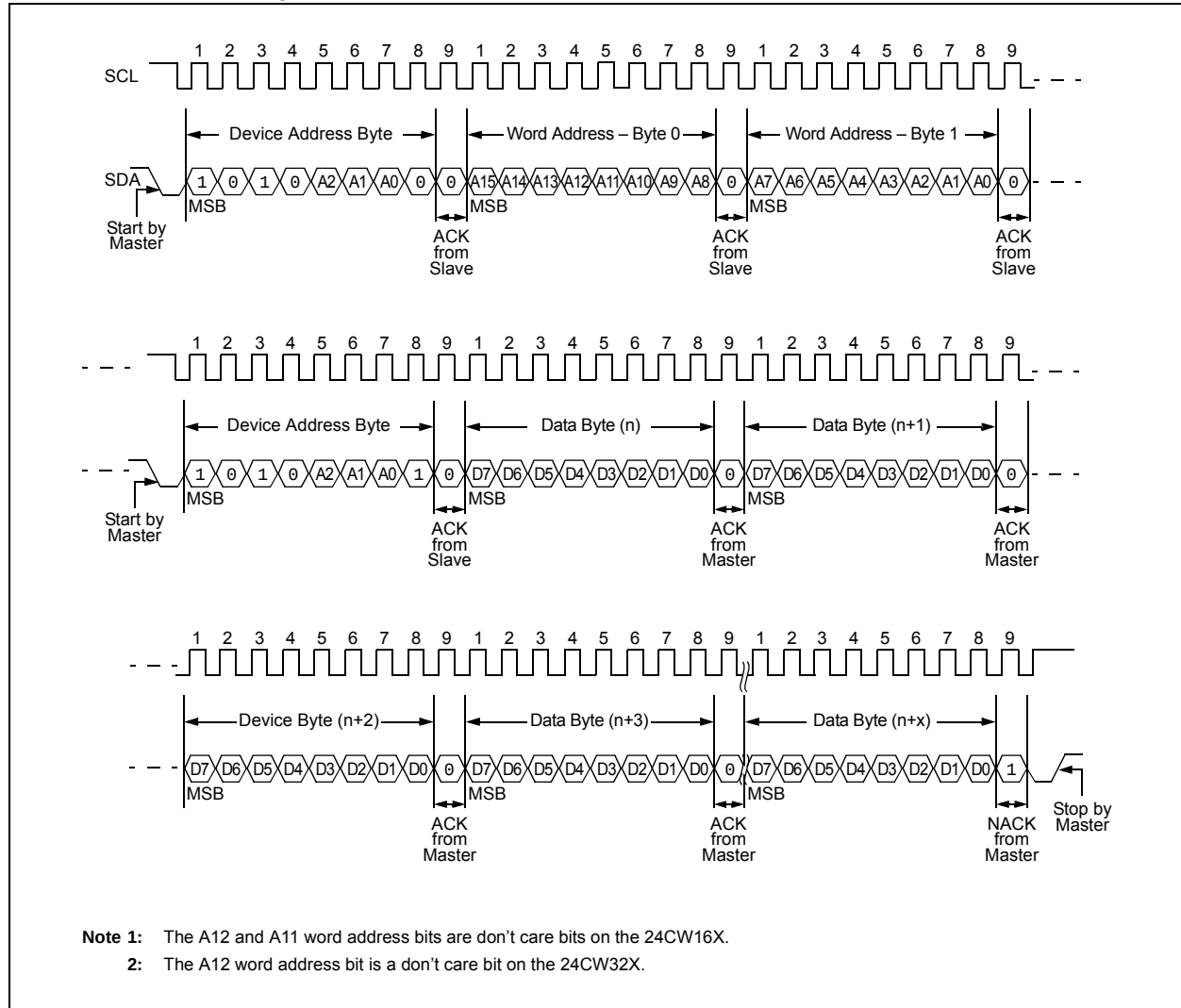
## 7.3 Sequential Read

A sequential read is initiated by either a current address read or a random read. After the master receives a data byte, the master responds with an Acknowledge. As long as the EEPROM receives an ACK, it will continue to increment the word address and serially clock out the sequential data byte. When the maximum memory address is reached, the internal Address Pointer will automatically roll over from the

end of the array to word address, 0000h, if the master Acknowledges the byte received from the end of the array.

All types of read operations will be terminated if the master does not respond with an ACK (it NACKs) during the ninth clock cycle, which will force the device into Standby mode. After the NACK response, the master may send a Stop condition to complete the protocol or it can send a Start condition to begin the next sequence.

**FIGURE 7-3: SEQUENTIAL READ**



# 24CW16X/24CW32X/24CW64X

## 8.0 CONFIGURATION REGISTERS

The 24CW Series device contains a pair of 8-bit Configuration registers which control software write protection and the hardware slave address.

The Configuration registers are accessed sequentially as Byte 0 and Byte 1, as shown in [Table 8-1](#).

If desired, the Configuration registers can be locked so that the registers are set to read-only and can no longer be modified. This makes the current software write protection and hardware slave address scheme permanent.

**TABLE 8-1: CONFIGURATION REGISTERS**

| Memory Region             | Byte | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2     | Bit 1 | Bit 0 |
|---------------------------|------|-------|-------|-------|-------|-------|-----------|-------|-------|
| Write Protection Register | 0    | —     | WRTE  | CCLK  | —     | WPRE  | WPB <1:0> |       | CRLB  |
| Hardware Address Register | 1    | —     | CHRB  | A0CK  | —     | —     | A2        | A1    | A0    |

## 8.1 Accessing the Configuration Registers

The value of the Configuration registers can be determined by executing a random read sequence, as shown in [Section 8.5 “Reading the Configuration Registers”](#). Changing the value of the Configuration registers is accomplished with a byte write sequence with the requirements outlined in [Section 8.4 “Writing to the Configuration Registers”](#).

Accessing these registers requires the use of ‘1010b’ (Ah) as the Device Type Identifier in the device address byte. Following the Device Type Identifier is the hardware slave address bits for which the values are determined by what is currently programmed in the HAR (see [Section 8.3 “Hardware Address Register”](#)). Finally, bit 0 is the Read/Write Select (R/W) bit, where a logic ‘1’ is used for reading and logic ‘0’ is used for writing. See [Table 3-1](#) for additional information.

**Note:** The hardware slave address bit values are initially factory preset but can be changed by the user. These bit values must match the current device configuration to receive an Acknowledge.

When accessing the Configuration registers, the word address must be sent to the device. All bits in the word address are ignored, except for the MSb which must be set to logic ‘1’. Refer to [Table 3-3](#) and [Table 3-4](#) for additional information.

## 8.2 Write Protection Register

The Write Protection Register (WPR) is Byte 0 of the sequential Configuration registers. The Write Protection Register format can be seen in [Register 8-1](#).

**REGISTER 8-1: WRITE PROTECTION REGISTER – BYTE 0**

|       |      |      |     |      |          |     |       |
|-------|------|------|-----|------|----------|-----|-------|
| U-0   | W-0  | W-0  | U-0 | R/W  | R/W      | R/W | R/W   |
| —     | WRTE | CCLK | —   | WPRE | WPB<1:0> |     | CRLB  |
| bit 7 |      |      |     |      |          |     | bit 0 |

**Legend:**

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as '0'  
 -n = Value at POR      '1' = Bit is set      '0' = Bit is cleared      x = Bit is unknown

|         |                                                                                                                                                                                                                                                                                                                   |
|---------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| bit 7   | <b>Unimplemented:</b> Read as '0'                                                                                                                                                                                                                                                                                 |
| bit 6   | <b>WRTE:</b> Configuration Registers Write bit<br>1 = Configuration registers are writable<br>0 = Configuration register writes are ignored                                                                                                                                                                       |
| bit 5   | <b>CCLK:</b> Configuration Registers Check Lock bit<br>Must match the CRLB bit when writing to the Configuration registers.                                                                                                                                                                                       |
| bit 4   | <b>Unimplemented:</b> Read as '0'                                                                                                                                                                                                                                                                                 |
| bit 3   | <b>WPRE:</b> Write Protection Register Enable bit<br>1 = Write protection is set by the WPB<1:0> bits<br>0 = No software write protection is enabled ( <b>Default</b> )                                                                                                                                           |
| bit 2-1 | <b>WPB&lt;1:0&gt;:</b> Write-Protect Block bits<br><u>If WPRE = 1:</u><br>11 = Entire EEPROM is write-protected<br>10 = Upper 3/4 of EEPROM is write-protected<br>01 = Upper 1/2 of EEPROM is write-protected<br>00 = Upper 1/4 of EEPROM is write-protected<br><u>If WPRE = 0:</u><br>Unused ( <b>Default</b> ). |
| bit 0   | <b>CRLB:</b> Configuration Registers Lock bit<br>1 = Configuration registers will become permanently locked<br>0 = Configuration registers can be written to ( <b>Default</b> )                                                                                                                                   |

**Configuration Registers Write bit (WRTE):** This bit must be set to a logic '1' in order to write to the Configuration registers. Failure to set the WRTE bit to a logic '1' will cause the device to ignore the write operation. When reading the WPR, the WRTE bit will always read as logic '0'.

**Configuration Registers Check Lock bit (CCLK):** This bit must match the CRLB bit when writing the Configuration registers. If the CCLK bit does not match the CRLB, the device will ignore the write operation. When reading the WPR, the CCLK bit will always read as logic '0'.

**Write Protection Register Enable bit (WPRE):** This bit is used to enable or disable the device software write protection feature. A logic '0' will disable the software write protection feature and a logic '1' will enable software write protection.

**Write-Protect Block bits (WPB<1:0>):** These bits allow four levels of protection for the memory array, provided that the WPRE bit is set to a logic '1'. If the WPRE bit is a logic '0', the state of the WPB<1:0> bits has no impact on device protection. The protected address ranges can be found in [Table 8-2](#).

**Configuration Registers Lock bit (CRLB):** This bit is used to permanently lock the current state of the WPR and HAR. A logic '0' indicates that these registers can be modified, whereas a logic '1' indicates that the WPR and HAR have been locked and can no longer be modified. To safeguard against accidental locking of these registers, the CCLK bit must match the CRLB bit sent to the device. If these bits do not match, the device will ignore the write operation.

**Note:** The Configuration registers cannot be unlocked once they are locked.

# 24CW16X/24CW32X/24CW64X

## 8.2.1 SOFTWARE WRITE PROTECTION

The EEPROM array in the 24CW Series will be protected from writing in accordance with the WPB<1:0> bits value as long as the WPRE bit is set to logic '1'. If the WPRE bit is set to logic '0', the WPB<1:0> bits are

ignored and no portion of the EEPROM array will be protected. The combination of these three bits creates five possible levels of protection for the device, as seen in [Table 8-2](#).

**TABLE 8-2: PROTECTED ADDRESS RANGE**

| Protection Level | WPRE | WPB1 | WPB0 | Protected Address Range |             |             |
|------------------|------|------|------|-------------------------|-------------|-------------|
|                  |      |      |      | 24CW16X                 | 24CW32X     | 24CW64X     |
| None             | 0    | x    | x    | None                    | None        | None        |
| Upper 1/4        | 1    | 0    | 0    | 0600h-07FFh             | 0C00h-0FFFh | 1800h-1FFFh |
| Upper 1/2        | 1    | 0    | 1    | 0400h-07FFh             | 0800h-0FFFh | 1000h-1FFFh |
| Upper 3/4        | 1    | 1    | 0    | 0200h-07FFh             | 0400h-0FFFh | 0800h-1FFFh |
| Entire Array     | 1    | 1    | 1    | 0000h-07FFh             | 0000h-0FFFh | 0000h-1FFFh |

## 8.3 Hardware Address Register

The Hardware Address Register (HAR) is Byte 1 of the sequential Configuration registers. The Hardware Address Register format can be seen in [Register 8-2](#).

**REGISTER 8-2: HARDWARE ADDRESS REGISTER – BYTE 1**

|       |      |      |     |     |     |     |       |
|-------|------|------|-----|-----|-----|-----|-------|
| U-0   | W-0  | W-0  | U-0 | U-0 | R/W | R/W | R/W   |
| —     | HWRE | A0CK | —   | —   | A2  | A1  | A0    |
| bit 7 |      |      |     |     |     |     | bit 0 |

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

|         |                                                                                                                                                                |
|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| bit 7   | <b>Unimplemented:</b> Read as '0'                                                                                                                              |
| bit 6   | <b>HWRE:</b> HAR Write Enable bit<br>1 = Configuration registers are writable<br>0 = Configuration register writes are ignored                                 |
| bit 5   | <b>A0CK:</b> Hardware Slave Address Check A0 bit<br>Must match A0 bit when writing the Configuration registers.                                                |
| bit 4-3 | <b>Unimplemented:</b> Read as '0'                                                                                                                              |
| bit 2   | <b>A2:</b> Hardware Slave Address A2 bit<br>1 = Hardware slave address bit A2 is set to a logic '1'<br>0 = Hardware slave address bit A2 is set to a logic '0' |
| bit 1   | <b>A1:</b> Hardware Slave Address A1 bit<br>1 = Hardware slave address bit A1 is set to a logic '1'<br>0 = Hardware slave address bit A1 is set to a logic '0' |
| bit 0   | <b>A0:</b> Hardware Slave Address A0 bit<br>1 = Hardware slave address bit A0 is set to a logic '1'<br>0 = Hardware slave address bit A0 is set to a logic '0' |

**HAR Write Enable bit (HWRE):** When writing to the HAR, this bit must be set to a logic '1'. Failure to set the HWRE bit to a logic '1' will cause the device to ignore the write operation. When reading the HAR, the HWRE bit will always read as logic '0'.

**Hardware Slave Address Check A0 bit (A0CK):** This bit must match the A0 bit when writing to the Configuration registers. If the A0CK bit does not match the A0 bit, the device will ignore the write operation. When reading the HAR, the A0CK bit will always read as logic '0'.

**Hardware Slave Address bits (A2, A1, A0):** The 3-bit hardware slave address is contained in bits A2, A1 and A0 of the HAR. These bits control the valid values in bit 3 through bit 1 (A2, A1, A0) of the device address byte. Details of the device address byte are found in [Section 3.3 "Device Addressing"](#).

**Note:** If multiple 24CW Series devices are on the same bus, each device must have unique hardware slave addresses to be accessed individually, including programming the HAR. Different preset hardware slave addresses are available. Contact your local sales representative for details.

# 24CW16X/24CW32X/24CW64X

## 8.4 Writing to the Configuration Registers

When writing to the Configuration registers, a byte write sequence must be sent to the device (see [Section 6.1 “Byte Write”](#) for additional information). The MSb of the word address must be set to logic ‘1’ in order to write to the Configuration registers.

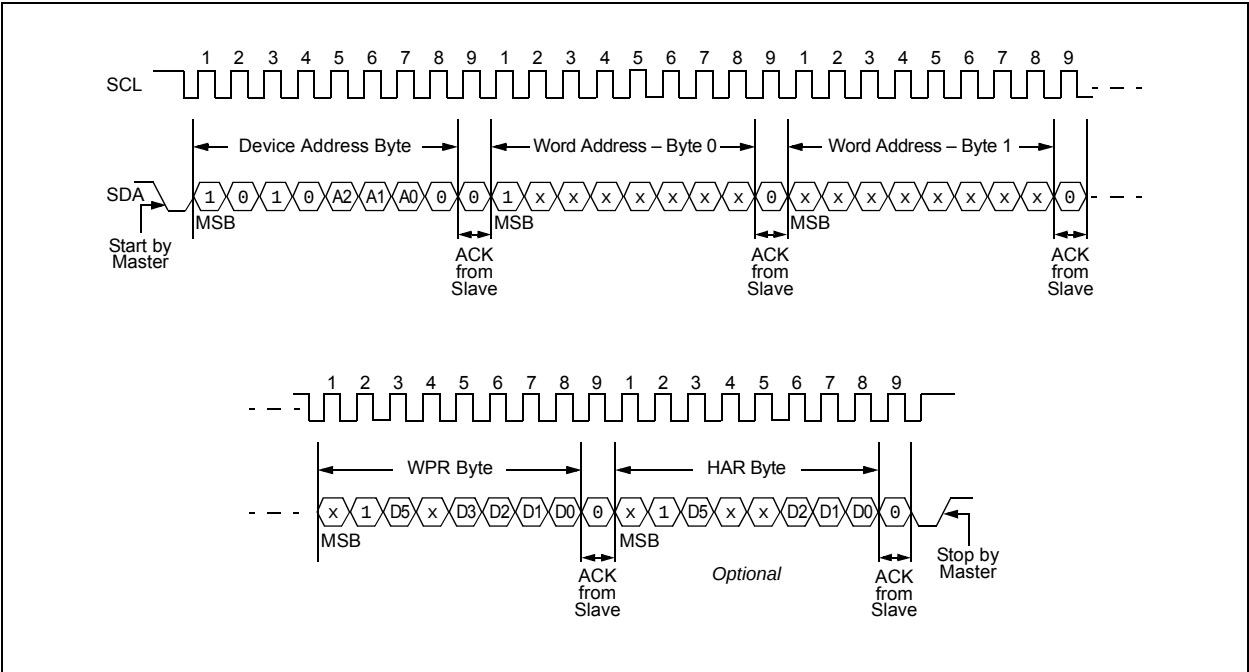
A valid WPR byte must be provided when writing to the Configuration registers. If the WPR byte is invalid, the operation will abort, the EEPROM will not Acknowledge any data bytes and the device will not execute the internal write cycle. Refer to [Section 8.2 “Write Protection Register”](#) for valid WPR byte values.

After sending a valid WPR byte, the HAR byte can optionally be sent. If the HAR byte is invalid, the operation will abort, the EEPROM will not Acknowledge any data bytes and the device will not execute the internal write cycle. Refer to [Section 8.3 “Hardware Address Register”](#) for valid HAR byte values.

Sending more than the WPR and HAR bytes to the 24CW Series will cause the write cycle to abort and the contents of the WPR and HAR will not be changed.

**Note:** If a polling routine has been implemented and the user writes new data values to the HAR, the user must send the new hardware slave address for the device to Acknowledge.

FIGURE 8-1: CONFIGURATION REGISTERS WRITE SEQUENCE



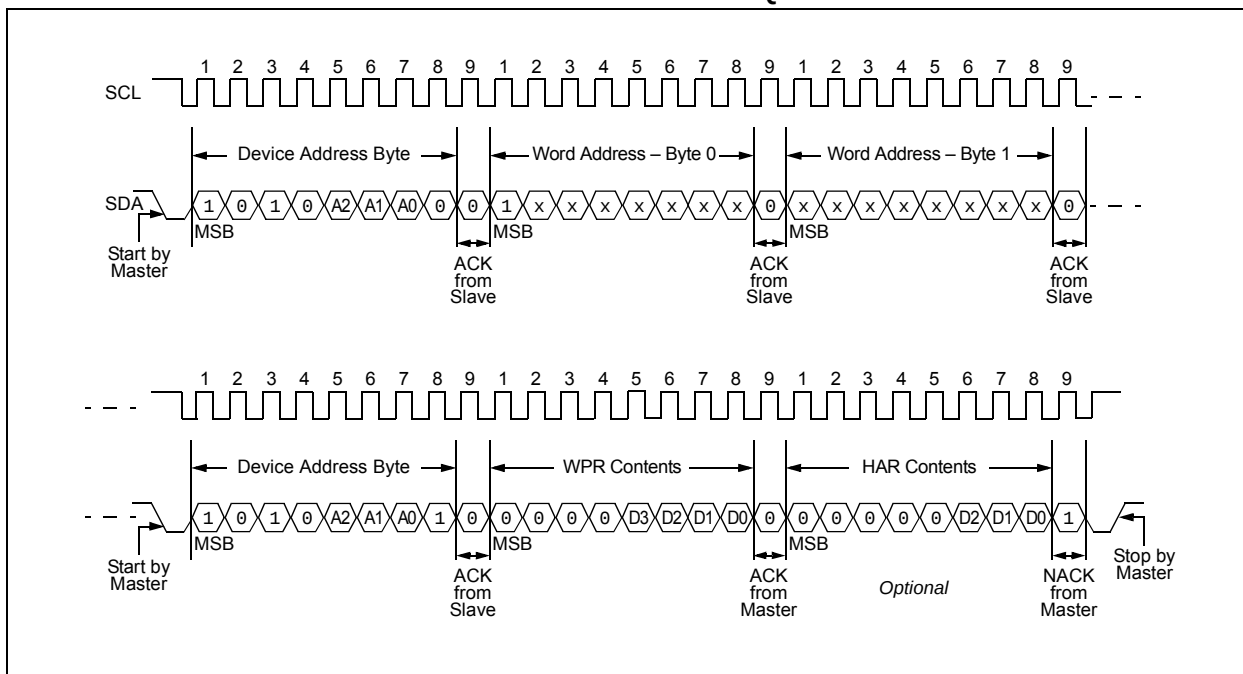
## 8.5 Reading the Configuration Registers

When reading the Configuration registers, a random read sequence must be sent to the device (see [Section 7.2 “Random Read”](#) for additional information). The MSb of the word address must be set to logic ‘1’ in order to read the Configuration registers.

It is not possible to read the contents of the Configuration registers with a current address read sequence. Due to the sequential nature of the Configuration registers, it is not possible to read only the HAR contents.

**Note:** The 24CW Series will automatically roll over from the HAR (Byte 1) back to the WPR (Byte 0) if the master continues to Acknowledge the data bytes during the read operation.

**FIGURE 8-2: CONFIGURATION REGISTERS READ SEQUENCE**



# 24CW16X/24CW32X/24CW64X

## 8.6 Locking the Configuration Registers

The locking mechanism of the Configuration registers is controlled through the CLRB bit found in the WPR byte.

When locking the Configuration registers, a byte write sequence must be sent to the device (see [Section 6.1 “Byte Write”](#) for additional information). The MSb of the word address must be set to logic ‘1’ in order to write to the Configuration registers.

**Note:** The Configuration registers cannot be unlocked once they are locked.

A valid WPR byte with the CCLK and CRLB bits set to a logic ‘1’ must be provided when locking the Configuration registers. If the WPR byte is invalid, the operation will abort, the EEPROM will not Acknowledge any data bytes and the device will not execute the internal write cycle. Refer to [Section 8.2 “Write Protection Register”](#) for valid WPR byte values.

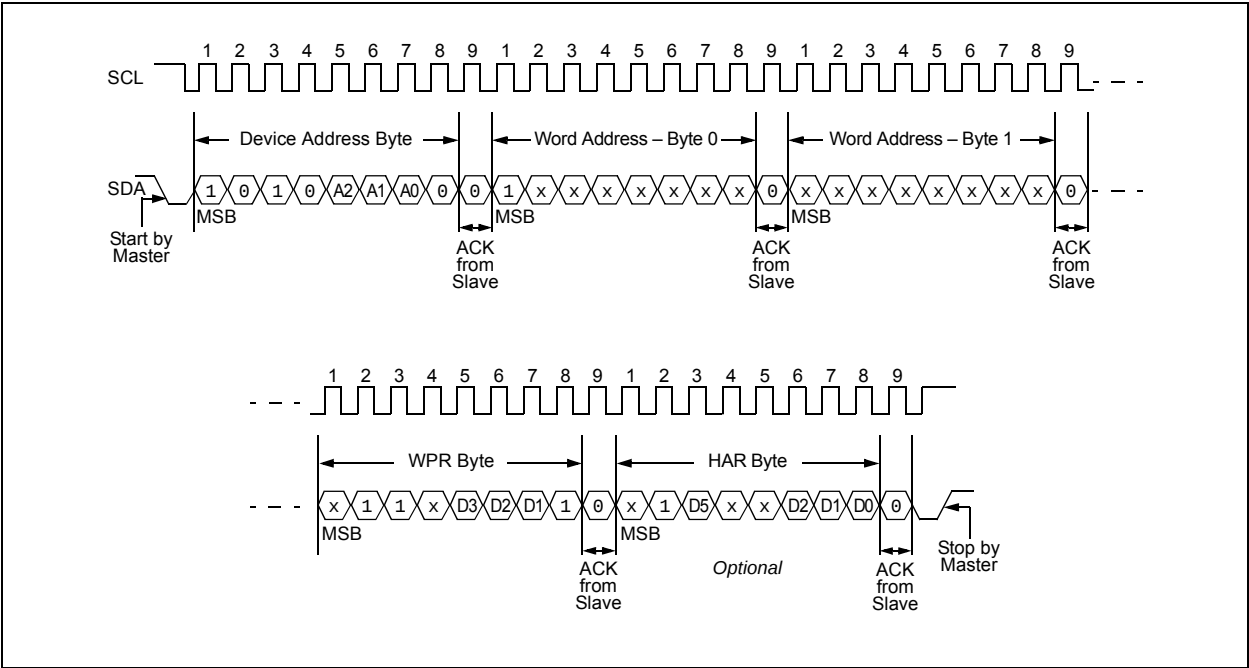
After sending a valid WPR byte, the HAR byte can optionally be sent. If the HAR byte is invalid, the operation will abort, the EEPROM will not Acknowledge any data bytes and the device will not execute the internal write cycle. Refer to [Section 8.3 “Hardware Address Register”](#) for valid HAR byte values.

It is possible to send only the WPR byte and lock the Configuration registers by omitting the HAR byte and sending a Stop condition after the WPR byte.

**Note:** If the HAR byte is omitted, the hardware slave address will be locked with its current values.

Sending more than the WPR and HAR bytes to the 24CW Series will cause the write cycle to abort and the contents of the WPR and HAR will not be changed.

FIGURE 8-3: CONFIGURATION REGISTER LOCK SEQUENCE



## 9.0 DEVICE DEFAULT CONDITION

The 24CW Series is delivered with the EEPROM array set to logic '1', resulting in FFh data in all locations of the EEPROM memory array.

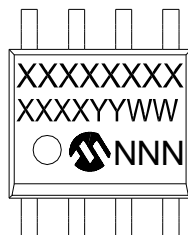
The Write Protection Register (WPR) is set to 00h and the Hardware Address Register (HAR) is preset in accordance with the ordering code selected. For factory preset hardware slave address bits, other than '000b', contact your local sales representative.

# 24CW16X/24CW32X/24CW64X

## 10.0 PACKAGING INFORMATION

### 10.1 Package Marking Information

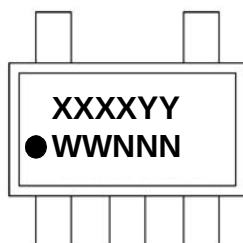
8-Lead 3.9 mm SOIC



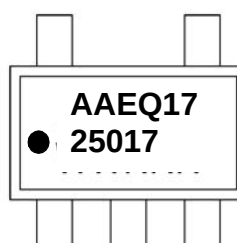
Example



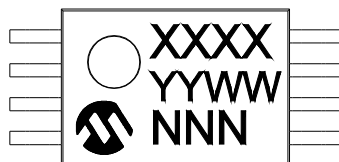
5-Lead SOT-23



Example



8-Lead 4.4 mm TSSOP



Example



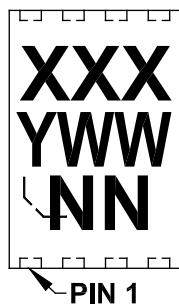
**Legend:** XX...X Customer-specific information  
Y Year code (last digit of calendar year)  
YY Year code (last 2 digits of calendar year)  
WW Week code (week of January 1 is week '01')  
NNN Alphanumeric traceability code  
\* These packages are RoHs compliant. The JEDEC designator can be found on the outer packaging for this package.

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

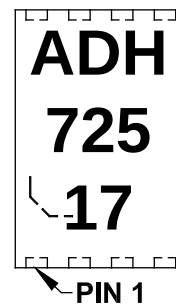
# 24CW16X/24CW32X/24CW64X

## Package Marking Information (Continued)

8-Lead 2x3 mm UDFN



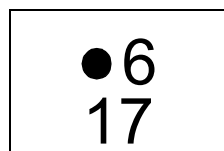
Example



4-Ball 0.4x0.4 mm CSP (CS0)



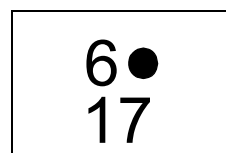
Example



4-Ball 0.5x0.4 mm CSP (CS1)



Example



| Part Number   | 1st Line Marking Codes |        |       |      |                          |                          |
|---------------|------------------------|--------|-------|------|--------------------------|--------------------------|
|               | SOIC                   | SOT-23 | TSSOP | UDFN | CSP (CS0) <sup>(1)</sup> | CSP (CS1) <sup>(2)</sup> |
| 24CW16 Series | 24CW160                | AAEN   | AADJ  | ADG  | —                        | —                        |
| 24CW32 Series | 24CW320                | AAEP   | AADK  | ADH  | —                        | —                        |
| 24CW64 Series | 24CW640                | AAEQ   | AADL  | ADJ  | ● 6                      | 6 ●                      |

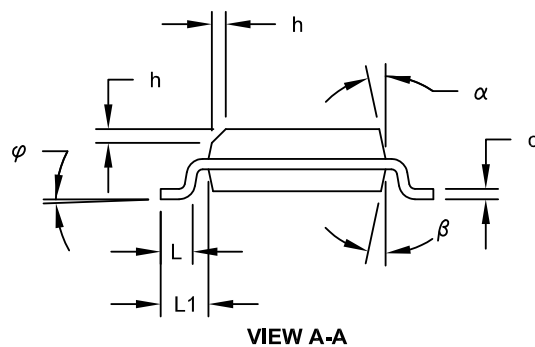
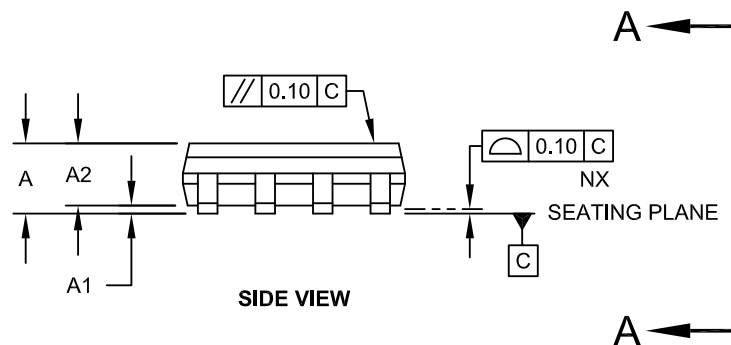
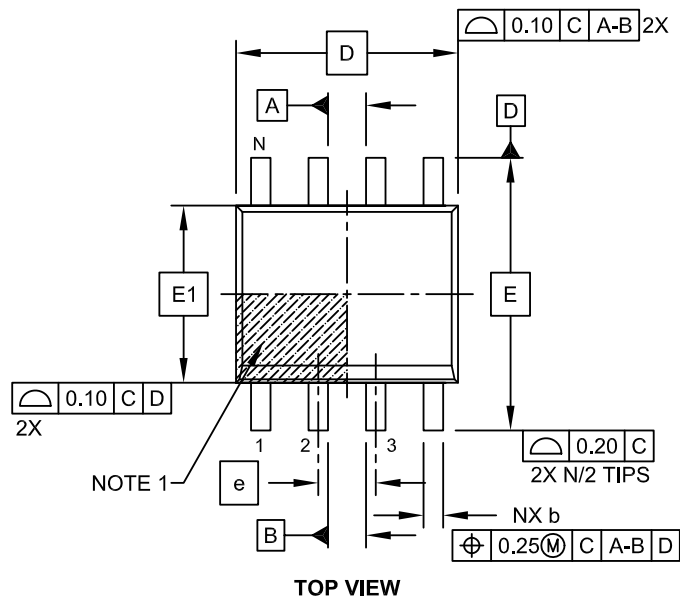
**Note 1:** CS0 CSP ball pitch is 0.4x0.4mm.

**Note 2:** CS1 CSP ball pitch is 0.5x0.4mm.

# 24CW16X/24CW32X/24CW64X

### 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

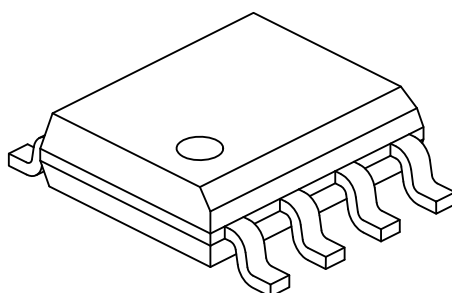


Microchip Technology Drawing No. C04-057C Sheet 1 of 2

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                    |    | MILLIMETERS |     |      |
|--------------------------|----|-------------|-----|------|
| Dimension Limits         |    | MIN         | NOM | MAX  |
| Number of Pins           | N  | 8           |     |      |
| Pitch                    | e  | 1.27 BSC    |     |      |
| Overall Height           | A  | -           | -   | 1.75 |
| Molded Package Thickness | A2 | 1.25        | -   | -    |
| Standoff §               | A1 | 0.10        | -   | 0.25 |
| Overall Width            | E  | 6.00 BSC    |     |      |
| Molded Package Width     | E1 | 3.90 BSC    |     |      |
| Overall Length           | D  | 4.90 BSC    |     |      |
| Chamfer (Optional)       | h  | 0.25        | -   | 0.50 |
| Foot Length              | L  | 0.40        | -   | 1.27 |
| Footprint                | L1 | 1.04 REF    |     |      |
| Foot Angle               | φ  | 0°          | -   | 8°   |
| Lead Thickness           | c  | 0.17        | -   | 0.25 |
| Lead Width               | b  | 0.31        | -   | 0.51 |
| Mold Draft Angle Top     | α  | 5°          | -   | 15°  |
| Mold Draft Angle Bottom  | β  | 5°          | -   | 15°  |

### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M

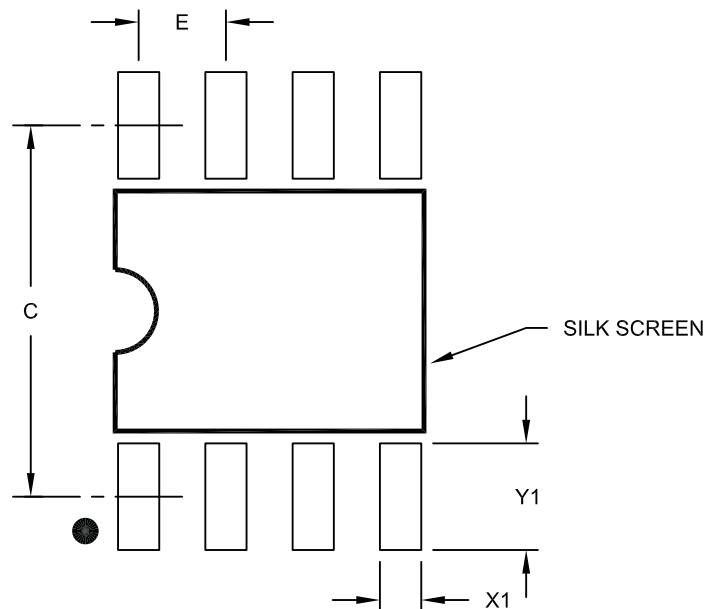
BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Small Outline (SN) – Narrow, 3.90 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units                   |    | MILLIMETERS |      |      |
|-------------------------|----|-------------|------|------|
| Dimension Limits        |    | MIN         | NOM  | MAX  |
| Contact Pitch           | E  | 1.27 BSC    |      |      |
| Contact Pad Spacing     | C  |             | 5.40 |      |
| Contact Pad Width (X8)  | X1 |             |      | 0.60 |
| Contact Pad Length (X8) | Y1 |             |      | 1.55 |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

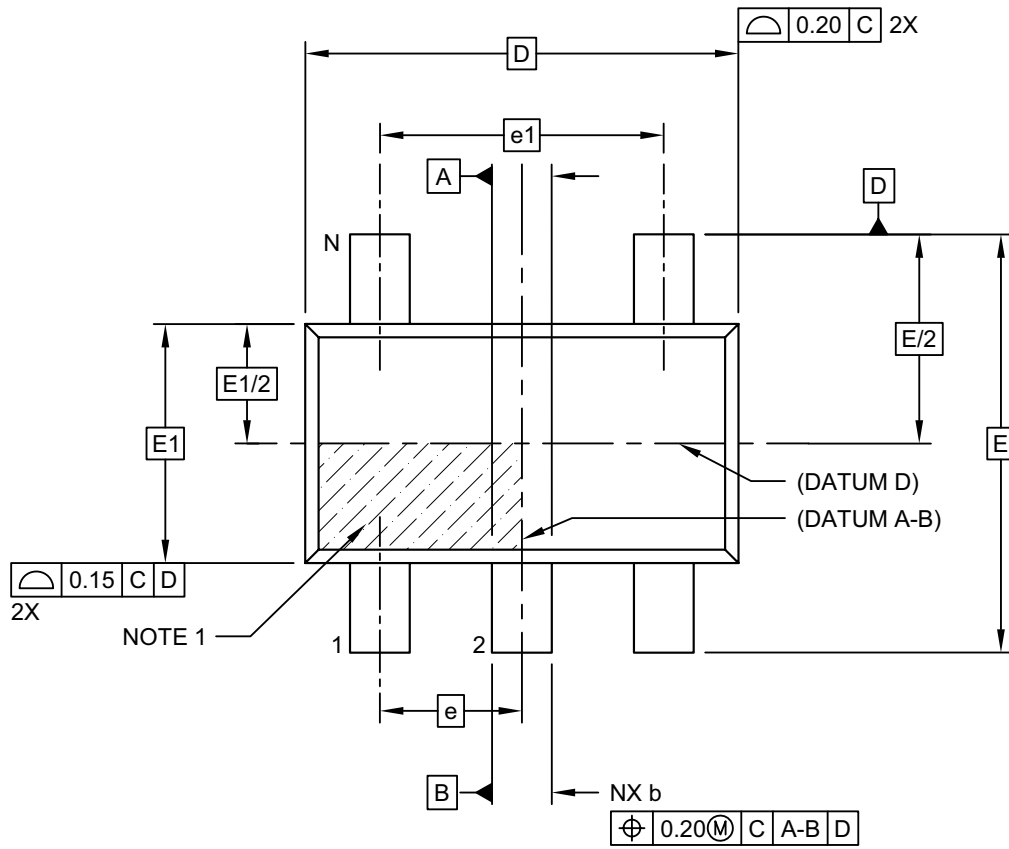
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

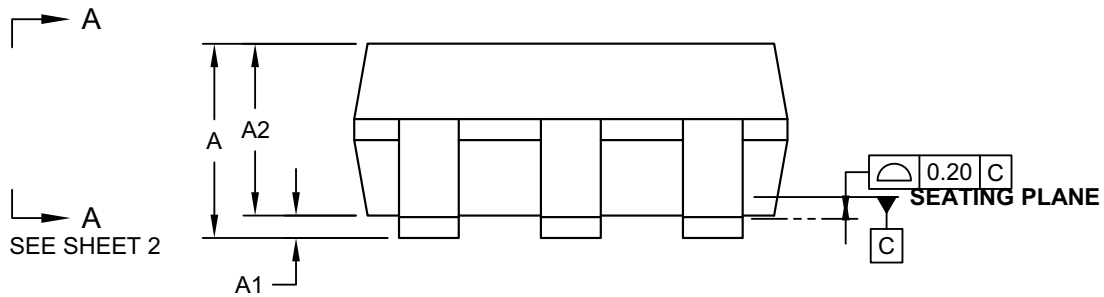
# 24CW16X/24CW32X/24CW64X

## 5-Lead Plastic Small Outline Transistor (OT) [SOT23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



TOP VIEW



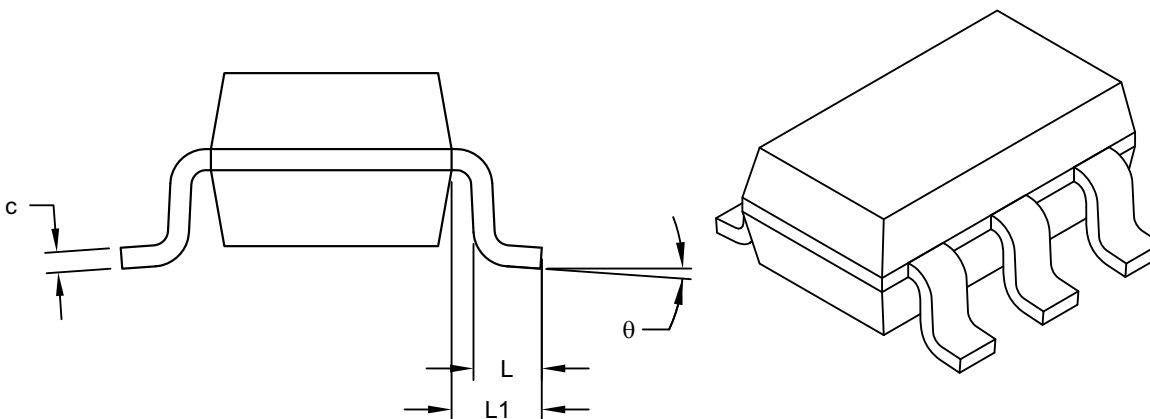
SIDE VIEW

Microchip Technology Drawing C04-028D [OT] Sheet 1 of 2

# 24CW16X/24CW32X/24CW64X

## 5-Lead Plastic Small Outline Transistor (OT) [SOT23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



VIEW A-A  
SHEET 1

|                          |    | Units | MILLIMETERS |     |      |
|--------------------------|----|-------|-------------|-----|------|
| Dimension Limits         |    |       | MIN         | NOM | MAX  |
| Number of Pins           | N  |       | 6           |     |      |
| Pitch                    | e  |       | 0.95 BSC    |     |      |
| Outside lead pitch       | e1 |       | 1.90 BSC    |     |      |
| Overall Height           | A  | 0.90  | -           | -   | 1.45 |
| Molded Package Thickness | A2 | 0.89  | -           | -   | 1.30 |
| Standoff                 | A1 | -     | -           | -   | 0.15 |
| Overall Width            | E  |       | 2.80 BSC    |     |      |
| Molded Package Width     | E1 |       | 1.60 BSC    |     |      |
| Overall Length           | D  |       | 2.90 BSC    |     |      |
| Foot Length              | L  | 0.30  | -           | -   | 0.60 |
| Footprint                | L1 |       | 0.60 REF    |     |      |
| Foot Angle               | φ  | 0°    | -           | -   | 10°  |
| Lead Thickness           | c  | 0.08  | -           | -   | 0.26 |
| Lead Width               | b  | 0.20  | -           | -   | 0.51 |

**Notes:**

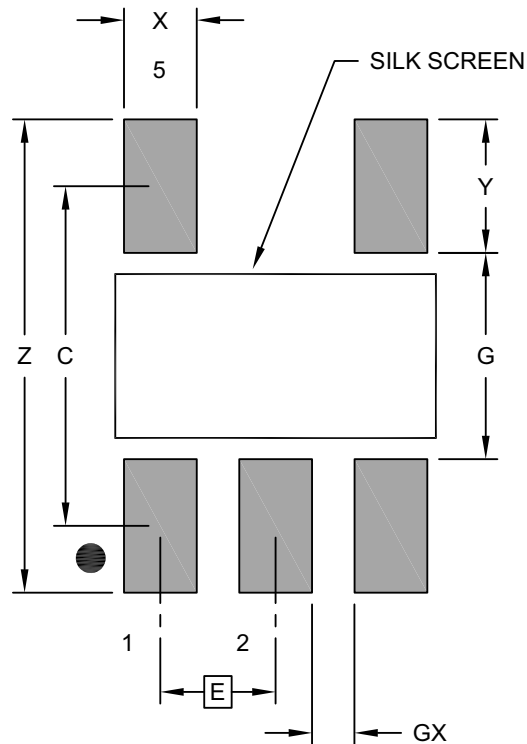
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25mm per side.
- Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.  
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-091D [OT] Sheet 2 of 2

# 24CW16X/24CW32X/24CW64X

## 5-Lead Plastic Small Outline Transistor (OT) [SOT23]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units                   |    | MILLIMETERS |      |      |
|-------------------------|----|-------------|------|------|
| Dimension Limits        |    | MIN         | NOM  | MAX  |
| Contact Pitch           | E  | 0.95 BSC    |      |      |
| Contact Pad Spacing     | C  |             | 2.80 |      |
| Contact Pad Width (X5)  | X  |             |      | 0.60 |
| Contact Pad Length (X5) | Y  |             |      | 1.10 |
| Distance Between Pads   | G  | 1.70        |      |      |
| Distance Between Pads   | GX | 0.35        |      |      |
| Overall Width           | Z  |             |      | 3.90 |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

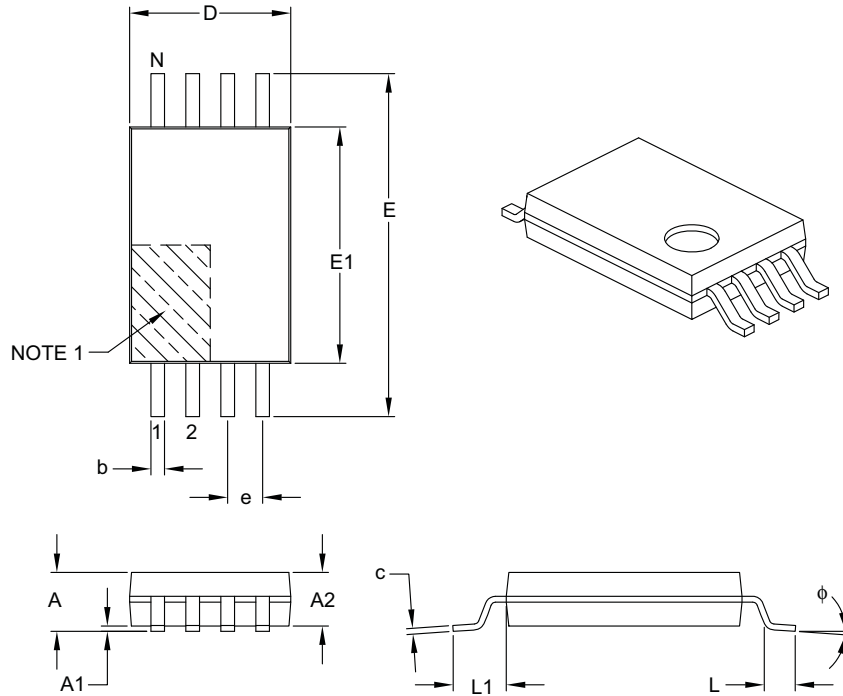
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2091A [OT]

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Thin Shrink Small Outline (ST) – 4.4 mm Body [TSSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                    |    | MILLIMETERS |      |      |
|--------------------------|----|-------------|------|------|
| Dimension Limits         |    | MIN         | NOM  | MAX  |
| Number of Pins           | N  | 8           |      |      |
| Pitch                    | e  | 0.65 BSC    |      |      |
| Overall Height           | A  | –           | –    | 1.20 |
| Molded Package Thickness | A2 | 0.80        | 1.00 | 1.05 |
| Standoff                 | A1 | 0.05        | –    | 0.15 |
| Overall Width            | E  | 6.40 BSC    |      |      |
| Molded Package Width     | E1 | 4.30        | 4.40 | 4.50 |
| Molded Package Length    | D  | 2.90        | 3.00 | 3.10 |
| Foot Length              | L  | 0.45        | 0.60 | 0.75 |
| Footprint                | L1 | 1.00 REF    |      |      |
| Foot Angle               | φ  | 0°          | –    | 8°   |
| Lead Thickness           | c  | 0.09        | –    | 0.20 |
| Lead Width               | b  | 0.19        | –    | 0.30 |

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

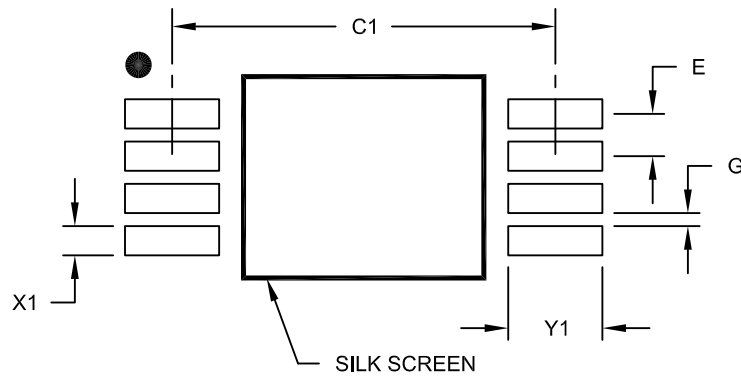
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-086B

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



### RECOMMENDED LAND PATTERN

| Units                   |    | MILLIMETERS |      |      |
|-------------------------|----|-------------|------|------|
| Dimension Limits        |    | MIN         | NOM  | MAX  |
| Contact Pitch           | E  | 0.65 BSC    |      |      |
| Contact Pad Spacing     | C1 |             | 5.90 |      |
| Contact Pad Width (X8)  | X1 |             |      | 0.45 |
| Contact Pad Length (X8) | Y1 |             |      | 1.45 |
| Distance Between Pads   | G  | 0.20        |      |      |

#### Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

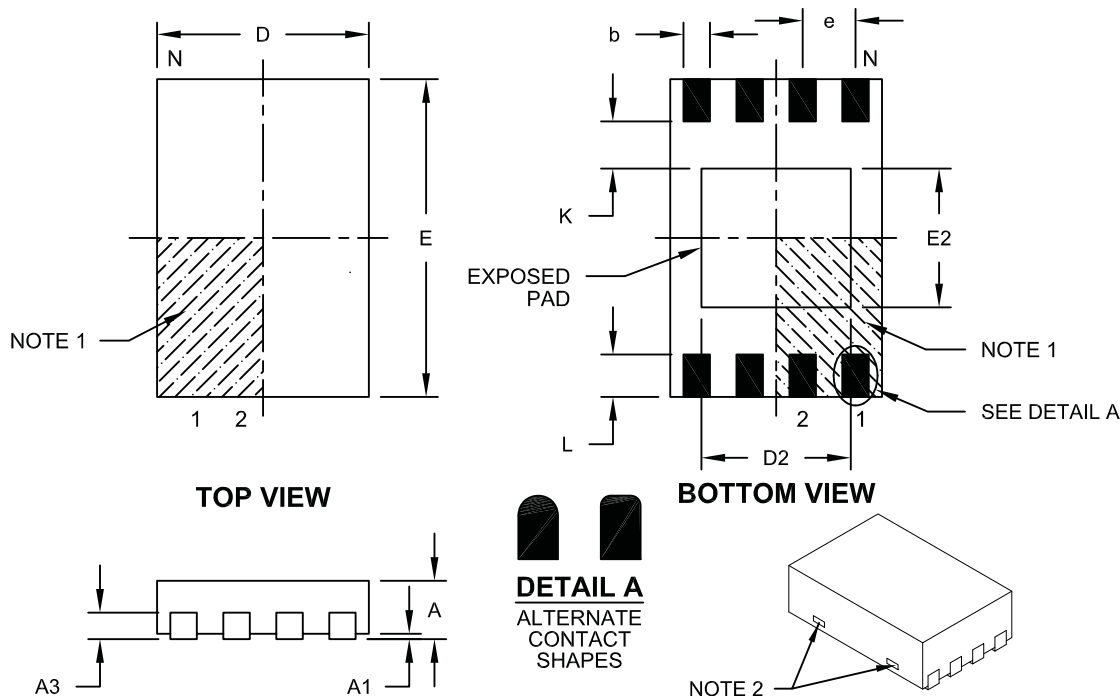
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2086A

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Dual Flat, No Lead Package (MU) – 2x3x0.5 mm Body [UDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                  |        | MILLIMETERS |      |      |
|------------------------|--------|-------------|------|------|
| Dimension              | Limits | MIN         | NOM  | MAX  |
| Number of Pins         | N      | 8           |      |      |
| Pitch                  | e      | 0.50 BSC    |      |      |
| Overall Height         | A      | 0.45        | 0.50 | 0.55 |
| Standoff               | A1     |             |      | 0.07 |
| Contact Thickness      | A3     | 0.127 REF   |      |      |
| Overall Length         | D      | 1.95        | 2.00 | 2.05 |
| Overall Width          | E      | 2.95        | 3.00 | 3.05 |
| Exposed Pad Length     | D2     | 1.30        | 1.40 | 1.50 |
| Exposed Pad Width      | E2     | 1.20        | 1.30 | 1.40 |
| Contact Width          | b      | 0.20        | 0.25 | 0.30 |
| Contact Length         | L      | 0.25        | 0.30 | 0.35 |
| Contact-to-Exposed Pad | K      | 0.55 REF    |      |      |

### Notes:

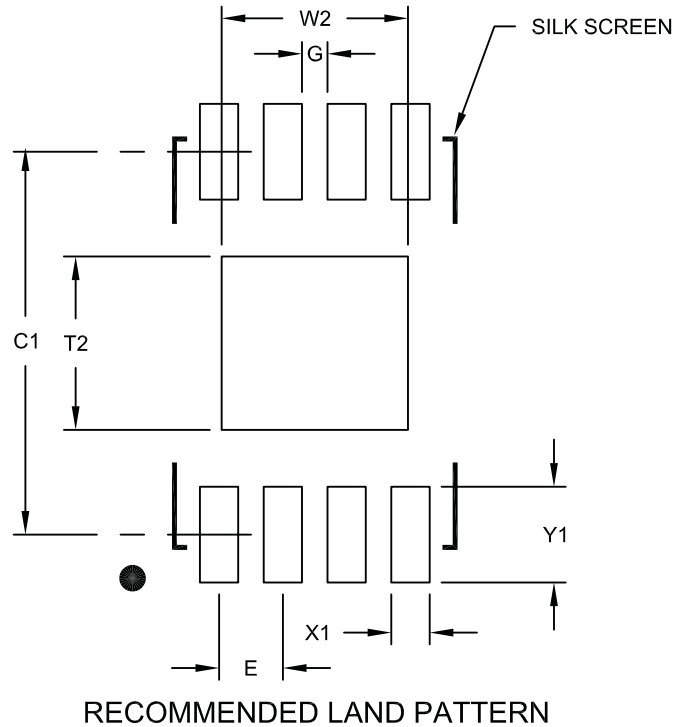
- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Package may have one or more exposed tie bars at ends.
- Package is saw singulated
- Dimensioning and tolerancing per ASME Y14.5M
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-136B

# 24CW16X/24CW32X/24CW64X

## 8-Lead Plastic Dual Flat, No Lead Package (MU) – 2x3x0.5 mm Body [UDFN]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



| Units                      |    | MILLIMETERS |      |      |
|----------------------------|----|-------------|------|------|
| Dimension Limits           |    | MIN         | NOM  | MAX  |
| Contact Pitch              | E  | 0.50 BSC    |      |      |
| Optional Center Pad Width  | W2 |             |      | 1.46 |
| Optional Center Pad Length | T2 |             |      | 1.36 |
| Contact Pad Spacing        | C1 |             | 3.00 |      |
| Contact Pad Width (X8)     | X1 |             |      | 0.30 |
| Contact Pad Length (X8)    | Y1 |             |      | 0.75 |
| Distance Between Pads      | G  | 0.20        |      |      |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

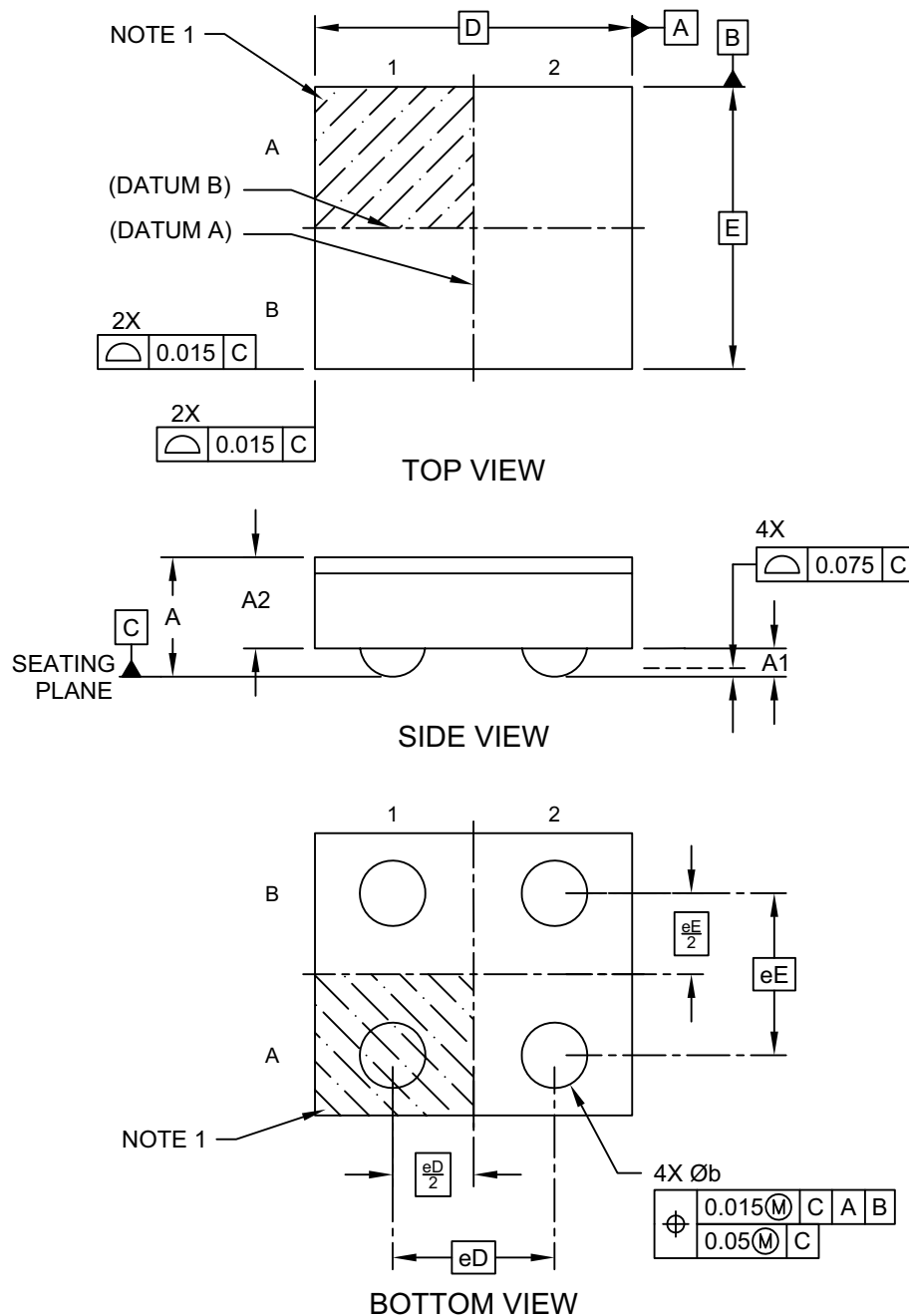
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2136A

## 24CW16X/24CW32X/24CW64X

#### 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.4 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

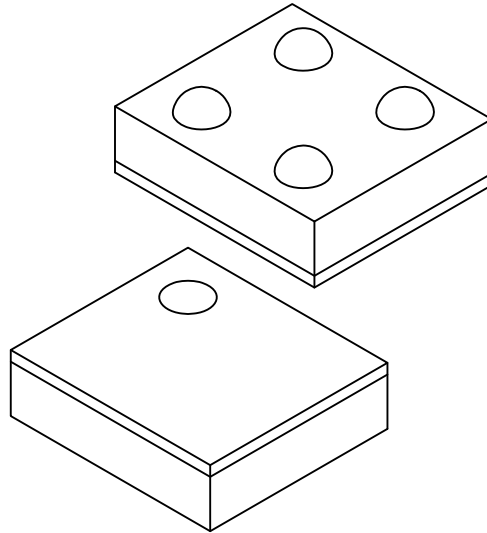


Microchip Technology Drawing C04-6047 Rev. A Sheet 1 of 2

# 24CW16X/24CW32X/24CW64X

## 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.4 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units               |    | MILLIMETERS                   |       |       |
|---------------------|----|-------------------------------|-------|-------|
| Dimension Limits    |    | MIN                           | NOM   | MAX   |
| Number of Terminals | N  | 4                             |       |       |
| Bump Pitch          | eD | 0.40 BSC                      |       |       |
| Bump Pitch          | eE | 0.40 BSC                      |       |       |
| Overall Height      | A  | 0.260                         | 0.295 | 0.330 |
| Standoff            | A1 | -                             | 0.070 | -     |
| Die Height          | A2 | -                             | 0.225 | -     |
| Overall Length      | D  | Contact Microchip for details |       |       |
| Overall Width       | E  | Contact Microchip for details |       |       |
| Terminal Width      | b  | 0.260                         | 0.300 | 0.340 |

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

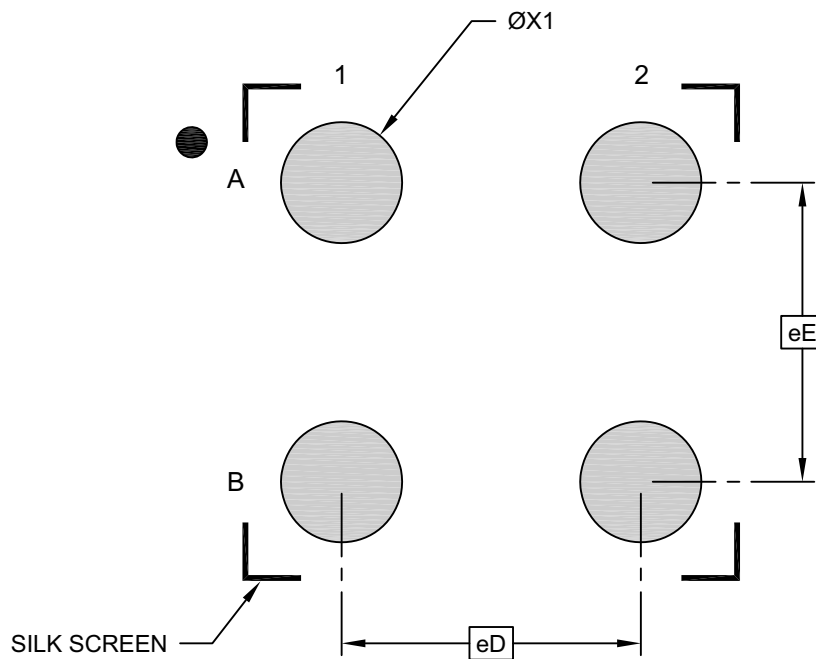
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-6047 Rev. A Sheet 2 of 2

# 24CW16X/24CW32X/24CW64X

## 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.4 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units            |     | MILLIMETERS |          |     |
|------------------|-----|-------------|----------|-----|
| Dimension Limits |     | MIN         | NOM      | MAX |
| Contact Pitch    | eD  |             | 0.40 BSC |     |
| Contact Pitch    | eE  |             | 0.40 BSC |     |
| Contact Diameter | ØX1 |             | 0.30     |     |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

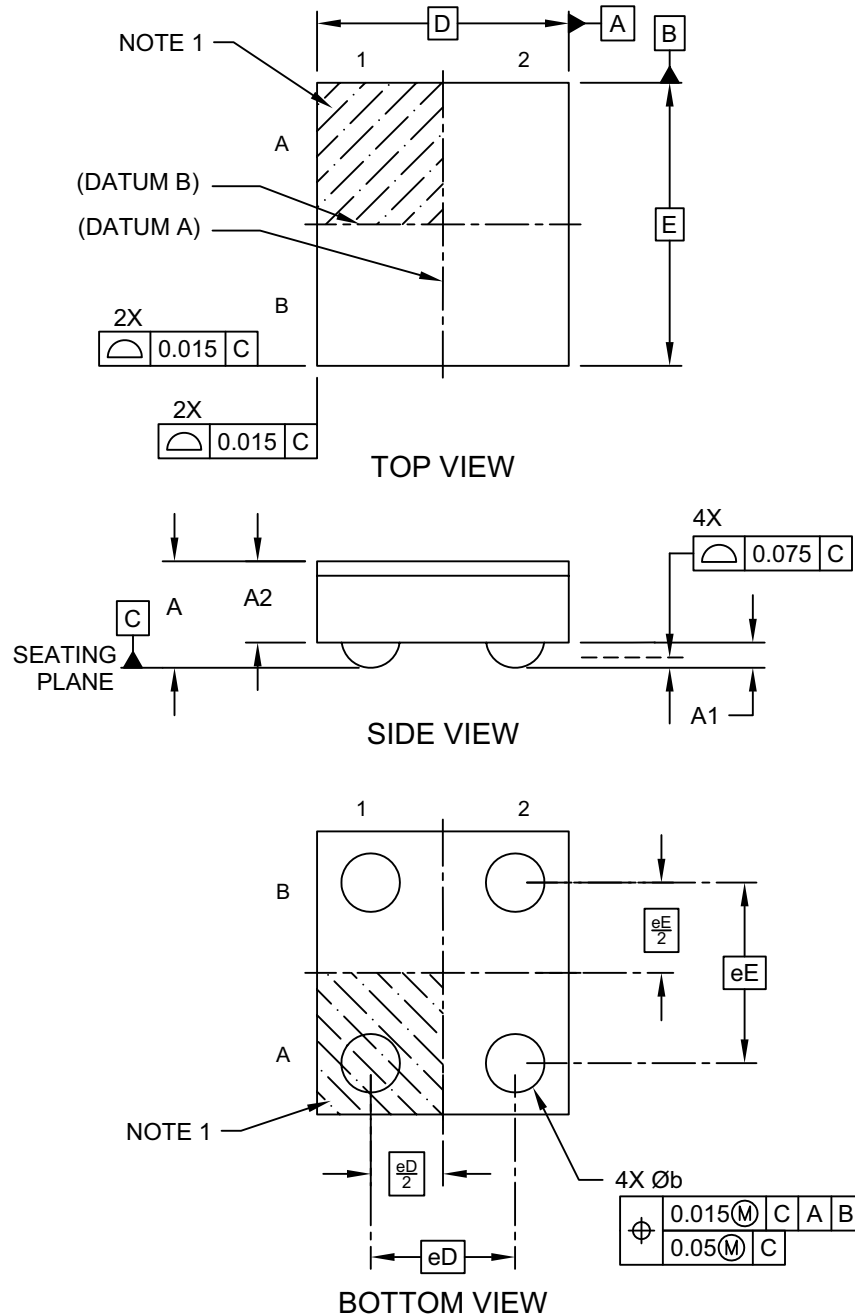
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-8047 Rev. A

# 24CW16X/24CW32X/24CW64X

## 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.5 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>

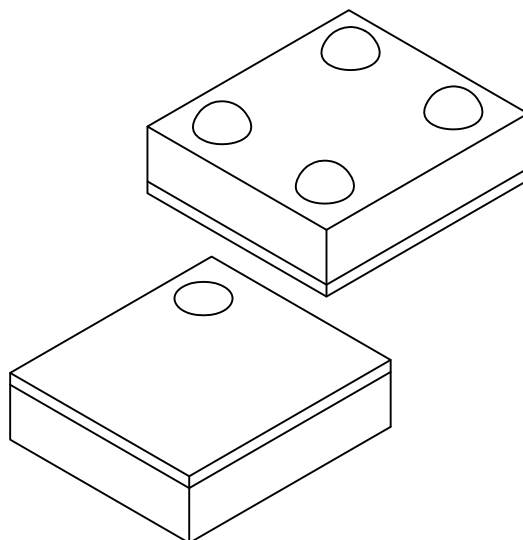


Microchip Technology Drawing C04-6048 Rev. A Sheet 1 of 2

# 24CW16X/24CW32X/24CW64X

## 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.5 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units               |    | MILLIMETERS                   |          |       |
|---------------------|----|-------------------------------|----------|-------|
| Dimension Limits    |    | MIN                           | NOM      | MAX   |
| Number of Terminals | N  | 4                             |          |       |
| Bump Pitch          | eD | 0.40 BSC                      |          |       |
| Bump Pitch          | eE |                               | 0.50 BSC |       |
| Overall Height      | A  | 0.260                         | 0.295    | 0.330 |
| Standoff            | A1 | -                             | 0.070    | -     |
| Die Height          | A2 | -                             | 0.225    | -     |
| Overall Length      | D  | Contact Microchip for details |          |       |
| Overall Width       | E  | Contact Microchip for details |          |       |
| Terminal Width      | b  | 0.260                         | 0.300    | 0.340 |

**Notes:**

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensioning and tolerancing per ASME Y14.5M

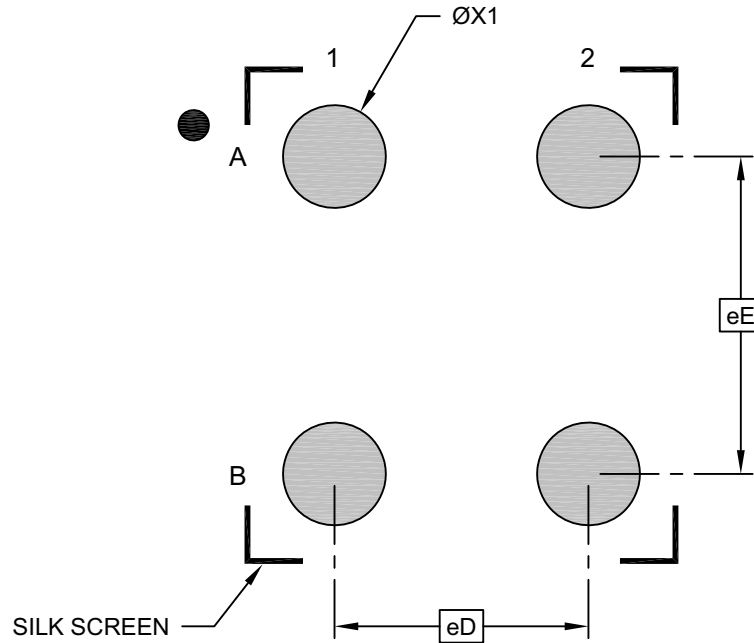
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-6048 Rev. A Sheet 2 of 2

## 4-Ball Wafer Level Chip Scale Package (CS) - 0.4x0.5 mm Ball Pitch [CSP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Dimension Limits | Units | MILLIMETERS |          |     |
|------------------|-------|-------------|----------|-----|
|                  |       | MIN         | NOM      | MAX |
| Contact Pitch    | eD    |             | 0.40 BSC |     |
| Contact Pitch    | eE    |             | 0.50 BSC |     |
| Contact Diameter | ØX1   |             | 0.30     |     |

**Notes:**

- Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
- For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process

Microchip Technology Drawing C04-8048 Rev. A

# 24CW16X/24CW32X/24CW64X

---

## APPENDIX A: REVISION HISTORY

### Revision A (10/2017)

Initial release of this document.

## THE MICROCHIP WEBSITE

Microchip provides online support via our website at [www.microchip.com](http://www.microchip.com). This website is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the website contains the following information:

- **Product Support** – Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** – Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- **Business of Microchip** – Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

## CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip website at [www.microchip.com](http://www.microchip.com). Under "Support", click on "Customer Change Notification" and follow the registration instructions.

## CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

**Technical support is available through the website at: <http://microchip.com/support>**

# 24CW16X/24CW32X/24CW64X

---

NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| <u>PART NO.</u>                                                                             | <u>X</u> <sup>(1)</sup> | <u>IXI</u> <sup>(1)</sup> | <u>X</u>          | <u>IXX</u> | <b>Examples:</b>     |                                                                                                                                                                                                                                                      |
|---------------------------------------------------------------------------------------------|-------------------------|---------------------------|-------------------|------------|----------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Device                                                                                      | Slave Address           | Tape and Reel Option      | Temperature Range | Package    |                      |                                                                                                                                                                                                                                                      |
| <b>Device:</b>                                                                              |                         |                           |                   |            | a) 24CW160-I/SN      | = 16-Kbit, Slave Address 0, Industrial Temp., SOIC Package.                                                                                                                                                                                          |
| 24CW16X = 16-Kbit I <sup>2</sup> C Compatible Serial EEPROM with Software Write Protection  |                         |                           |                   |            | b) 24CW320T-I/SN     | = 32-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., SOIC Package.                                                                                                                                                                           |
| 24CW32X = 32-Kbit I <sup>2</sup> C Compatible Serial EEPROM with Software Write Protection  |                         |                           |                   |            | c) 24CW640-I/SN      | = 64-Kbit, Slave Address 0, Industrial Temp., SOIC Package.                                                                                                                                                                                          |
| 24CW64X = 64-Kbit I <sup>2</sup> C Compatible Serial EEPROM with Software Write Protection  |                         |                           |                   |            | d) 24CW320-I/ST      | = 32-Kbit, Slave Address 0, Industrial Temp., TSSOP Package.                                                                                                                                                                                         |
| <b>Slave Address:</b> <sup>(1)</sup>                                                        |                         |                           |                   |            | e) 24CW640T-I/ST     | = 64-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., TSSOP Package.                                                                                                                                                                          |
| 0 = Hardware Slave Address '000b'                                                           |                         |                           |                   |            | f) 24CW160T-I/OT     | = 16-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., SOT-23 Package.                                                                                                                                                                         |
| 1 = Hardware Slave Address '001b'                                                           |                         |                           |                   |            | g) 24CW320T-I/OT     | = 32-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., SOT-23 Package.                                                                                                                                                                         |
| 2 = Hardware Slave Address '010b'                                                           |                         |                           |                   |            | h) 24CW320T-I/MU     | = 32-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., UDFN Package.                                                                                                                                                                           |
| 3 = Hardware Slave Address '011b'                                                           |                         |                           |                   |            | i) 24CW640T-I/MU     | = 64-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., UDFN Package.                                                                                                                                                                           |
| 4 = Hardware Slave Address '100b'                                                           |                         |                           |                   |            | j) 24CW640T-I/CS0668 | = 64-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., CS0 Package.                                                                                                                                                                            |
| 5 = Hardware Slave Address '101b'                                                           |                         |                           |                   |            | k) 24CW640T-I/CS1668 | = 64-Kbit, Slave Address 0, Tape and Reel, Industrial Temp., CS1 Package.                                                                                                                                                                            |
| 6 = Hardware Slave Address '110b'                                                           |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| 7 = Hardware Slave Address '111b'                                                           |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| <b>Tape and Reel Option:</b>                                                                |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| Blank = Standard Packaging (tube or tray)                                                   |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| T = Tape and Reel <sup>(1)</sup>                                                            |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| <b>Temperature Range:</b>                                                                   |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| I = -40°C to +85°C (Industrial)                                                             |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| <b>Package:</b>                                                                             |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| SN = 8-Lead Plastic Small Outline – Narrow, 3.90 mm Body                                    |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| OT = 5-Lead Plastic Small Outline Transistor                                                |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| ST = 8-Lead Plastic Thin Shrink Small Outline – 4.4 mm Body                                 |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| MU = 8-Lead Plastic Dual Flat, No Lead Package – 2x3x0.5 mm                                 |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| CS0668 = 4-Ball Extremely Thin Fine Pitch Wafer Level Chip Scale Package – 0.4x0.4 mm Pitch |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
| CS1668 = 4-Ball Extremely Thin Fine Pitch Wafer Level Chip Scale Package – 0.5x0.4 mm Pitch |                         |                           |                   |            |                      |                                                                                                                                                                                                                                                      |
|                                                                                             |                         |                           |                   |            | <b>Note 1:</b>       | Slave Address and Tape and Reel identifiers only appear in the catalog part number description. These identifiers are used for ordering purposes and are not printed on the device package. Check with your Microchip Sales Office for availability. |

# 24CW SERIES

---

NOTES:

---

**Note the following details of the code protection feature on Microchip devices:**

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

---

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

*Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.*

**QUALITY MANAGEMENT SYSTEM**  
**CERTIFIED BY DNV**  
**== ISO/TS 16949 ==**

### Trademarks

The Microchip name and logo, the Microchip logo, AnyRate, AVR, AVR logo, AVR Freaks, BeaconThings, BitCloud, chipKIT, chipKIT logo, CryptoMemory, CryptoRF, dsPIC, FlashFlex, flexPWR, Helder, JukeBlox, KEELOQ, KEELOQ logo, Kleer, LANCheck, LINK MD, maXStylus, maXTouch, MediaLB, megaAVR, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, Prochip Designer, QTouch, RightTouch, SAM-BA, SpyNIC, SST, SST Logo, SuperFlash, tinyAVR, UNI/O, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

ClockWorks, The Embedded Control Solutions Company, EtherSynch, Hyper Speed Control, HyperLight Load, IntelliMOS, mTouch, Precision Edge, and Quiet-Wire are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, AnyIn, AnyOut, BodyCom, CodeGuard, CryptoAuthentication, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, EtherGREEN, In-Circuit Serial Programming, ICSP, Inter-Chip Connectivity, JitterBlocker, KleerNet, KleerNet logo, Mindi, MiWi, motorBench, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICKit, PICtail, PureSilicon, QMatrix, RightTouch logo, REAL ICE, Ripple Blocker, SAM-ICE, Serial Quad I/O, SMART-I.S., SQI, SuperSwitcher, SuperSwitcher II, Total Endurance, TSHARC, USBCheck, VariSense, ViewSpan, WiperLock, Wireless DNA, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2017, Microchip Technology Incorporated, All Rights Reserved.

ISBN: 978-1-5224-2214-3

## Worldwide Sales and Service

### AMERICAS

**Corporate Office**  
 2355 West Chandler Blvd.  
 Chandler, AZ 85224-6199  
 Tel: 480-792-7200  
 Fax: 480-792-7277  
 Technical Support:  
<http://www.microchip.com/support>  
 Web Address:  
[www.microchip.com](http://www.microchip.com)

**Atlanta**  
 Duluth, GA  
 Tel: 678-957-9614  
 Fax: 678-957-1455

**Austin, TX**  
 Tel: 512-257-3370

**Boston**  
 Westborough, MA  
 Tel: 774-760-0087  
 Fax: 774-760-0088

**Chicago**  
 Itasca, IL  
 Tel: 630-285-0071  
 Fax: 630-285-0075

**Dallas**  
 Addison, TX  
 Tel: 972-818-7423  
 Fax: 972-818-2924

**Detroit**  
 Novi, MI  
 Tel: 248-848-4000

**Houston, TX**  
 Tel: 281-894-5983

**Indianapolis**  
 Noblesville, IN  
 Tel: 317-773-8323  
 Fax: 317-773-5453  
 Tel: 317-536-2380

**Los Angeles**  
 Mission Viejo, CA  
 Tel: 949-462-9523  
 Fax: 949-462-9608  
 Tel: 951-273-7800

**Raleigh, NC**  
 Tel: 919-844-7510

**New York, NY**  
 Tel: 631-435-6000

**San Jose, CA**  
 Tel: 408-735-9110  
 Tel: 408-436-4270

**Canada - Toronto**  
 Tel: 905-695-1980  
 Fax: 905-695-2078

### ASIA/PACIFIC

**Asia Pacific Office**  
 Suites 3707-14, 37th Floor  
 Tower 6, The Gateway  
 Harbour City, Kowloon

**Hong Kong**  
 Tel: 852-2943-5100  
 Fax: 852-2401-3431

**Australia - Sydney**  
 Tel: 61-2-9868-6733  
 Fax: 61-2-9868-6755

**China - Beijing**  
 Tel: 86-10-8569-7000  
 Fax: 86-10-8528-2104

**China - Chengdu**  
 Tel: 86-28-8665-5511  
 Fax: 86-28-8665-7889

**China - Chongqing**  
 Tel: 86-23-8980-9588  
 Fax: 86-23-8980-9500

**China - Dongguan**  
 Tel: 86-769-8702-9880

**China - Guangzhou**  
 Tel: 86-20-8755-8029

**China - Hangzhou**  
 Tel: 86-571-8792-8115  
 Fax: 86-571-8792-8116

**China - Hong Kong SAR**  
 Tel: 852-2943-5100  
 Fax: 852-2401-3431

**China - Nanjing**  
 Tel: 86-25-8473-2460  
 Fax: 86-25-8473-2470

**China - Qingdao**  
 Tel: 86-532-8502-7355  
 Fax: 86-532-8502-7205

**China - Shanghai**  
 Tel: 86-21-3326-8000  
 Fax: 86-21-3326-8021

**China - Shenyang**  
 Tel: 86-24-2334-2829  
 Fax: 86-24-2334-2393

**China - Shenzhen**  
 Tel: 86-755-8864-2200  
 Fax: 86-755-8203-1760

**China - Wuhan**  
 Tel: 86-27-5980-5300  
 Fax: 86-27-5980-5118

**China - Xian**  
 Tel: 86-29-8833-7252  
 Fax: 86-29-8833-7256

### ASIA/PACIFIC

**China - Xiamen**  
 Tel: 86-592-2388138  
 Fax: 86-592-2388130

**China - Zhuhai**  
 Tel: 86-756-3210040  
 Fax: 86-756-3210049

**India - Bangalore**  
 Tel: 91-80-3090-4444  
 Fax: 91-80-3090-4123

**India - New Delhi**  
 Tel: 91-11-4160-8631  
 Fax: 91-11-4160-8632

**India - Pune**  
 Tel: 91-20-3019-1500

**Japan - Osaka**  
 Tel: 81-6-6152-7160  
 Fax: 81-6-6152-9310

**Japan - Tokyo**  
 Tel: 81-3-6880-3770  
 Fax: 81-3-6880-3771

**Korea - Daegu**  
 Tel: 82-53-744-4301  
 Fax: 82-53-744-4302

**Korea - Seoul**  
 Tel: 82-2-554-7200  
 Fax: 82-2-558-5932 or  
 82-2-558-5934

**Malaysia - Kuala Lumpur**  
 Tel: 60-3-6201-9857  
 Fax: 60-3-6201-9859

**Malaysia - Penang**  
 Tel: 60-4-227-8870  
 Fax: 60-4-227-4068

**Philippines - Manila**  
 Tel: 63-2-634-9065  
 Fax: 63-2-634-9069

**Singapore**  
 Tel: 65-6334-8870  
 Fax: 65-6334-8850

**Taiwan - Hsin Chu**  
 Tel: 886-3-5778-366  
 Fax: 886-3-5770-955

**Taiwan - Kaohsiung**  
 Tel: 886-7-213-7830

**Taiwan - Taipei**  
 Tel: 886-2-2508-8600  
 Fax: 886-2-2508-0102

**Thailand - Bangkok**  
 Tel: 66-2-694-1351  
 Fax: 66-2-694-1350

### EUROPE

**Austria - Wels**  
 Tel: 43-7242-2244-39  
 Fax: 43-7242-2244-393

**Denmark - Copenhagen**  
 Tel: 45-4450-2828  
 Fax: 45-4485-2829

**Finland - Espoo**  
 Tel: 358-9-4520-820

**France - Paris**  
 Tel: 33-1-69-53-63-20  
 Fax: 33-1-69-30-90-79

**France - Saint Cloud**  
 Tel: 33-1-30-60-70-00

**Germany - Garching**  
 Tel: 49-8931-9700

**Germany - Haan**  
 Tel: 49-2129-3766400

**Germany - Heilbronn**  
 Tel: 49-7131-67-3636

**Germany - Karlsruhe**  
 Tel: 49-721-625370

**Germany - Munich**  
 Tel: 49-89-627-144-0  
 Fax: 49-89-627-144-44

**Germany - Rosenheim**  
 Tel: 49-8031-354-560

**Israel - Ra'anana**  
 Tel: 972-9-744-7705

**Italy - Milan**  
 Tel: 39-0331-742611  
 Fax: 39-0331-466781

**Italy - Padova**  
 Tel: 39-049-7625286

**Netherlands - Drunen**  
 Tel: 31-416-690399  
 Fax: 31-416-690340

**Norway - Trondheim**  
 Tel: 47-7289-7561

**Poland - Warsaw**  
 Tel: 48-22-3325737

**Romania - Bucharest**  
 Tel: 40-21-407-87-50

**Spain - Madrid**  
 Tel: 34-91-708-08-90  
 Fax: 34-91-708-08-91

**Sweden - Gothenberg**  
 Tel: 46-31-704-60-40

**Sweden - Stockholm**  
 Tel: 46-8-5090-4654

**UK - Wokingham**  
 Tel: 44-118-921-5800  
 Fax: 44-118-921-5820

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

## Microchip:

[24CW160-I/SN](#) [24CW160-I/ST](#) [24CW160T-I/OT](#) [24CW160T-I/SN](#) [24CW160T-I/ST](#) [24CW320-I/SN](#) [24CW640T-I/CS0668](#) [24CW640T-I/CS1668](#) [24CW640T-I/OT](#) [24CW640T-I/SN](#) [24CW640T-I/ST](#) [24CW320-I/ST](#) [24CW320T-I/OT](#) [24CW320T-I/SN](#) [24CW320T-I/ST](#) [24CW640-I/SN](#) [24CW640-I/ST](#) [24CW160T-I/MU](#) [24CW320T-I/MU](#) [24CW640T-I/MU](#) [24CW160T-I/MUY](#) [24CW640T-I/MUY](#) [24CW320T-I/MUY](#) [24CW1280-I/SN](#) [24CW1280-I/ST](#)

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9